

ZEISS Connected quality solutions: Addressing the production-scale challenges using the laboratory-scale insights



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ZEISS Industrial Quality & Research

Portfolio

Shaping the Future - ZEISS Segments

Semiconductor Manufacturing Technology



Industrial Quality & Research



Medical Technology



Consumer Markets



Strategic Business Units

Semiconductor Manufacturing Optics	Semiconductor Manufacturing Mask Solutions	Process Control Solutions
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Industrial Quality Solutions	Research Microscopy Solutions
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Microsurgery	Ophthalmic Devices
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Vision Care	Consumer Products
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Facts

ZEISS Worldwide

Employees

31,260

Locations worldwide

100

Countries

50

 Headquarters:
Oberkochen, Germany



ZEISS – your global partner

Close to the customer – worldwide



ZEISS – Careers

<https://www.zeiss.com/corporate/int/careers.html>

We want you!

Your career – your future at ZEISS

You are a team player with an innovative spirit. An expert with real depth. You want to share your knowledge and gather as much experience as possible. You want to excel in your job and make your mark.

With your motivation and passion, you'll fit right in at ZEISS!

We're looking for people who are empathetic and passionate, who are committed to achieving their goals, and who get excited about challenging topics. People who deliver top performance and push the limits of what's possible. Who always strive to develop, accept responsibility, and take society into the future. As part of the global ZEISS team.



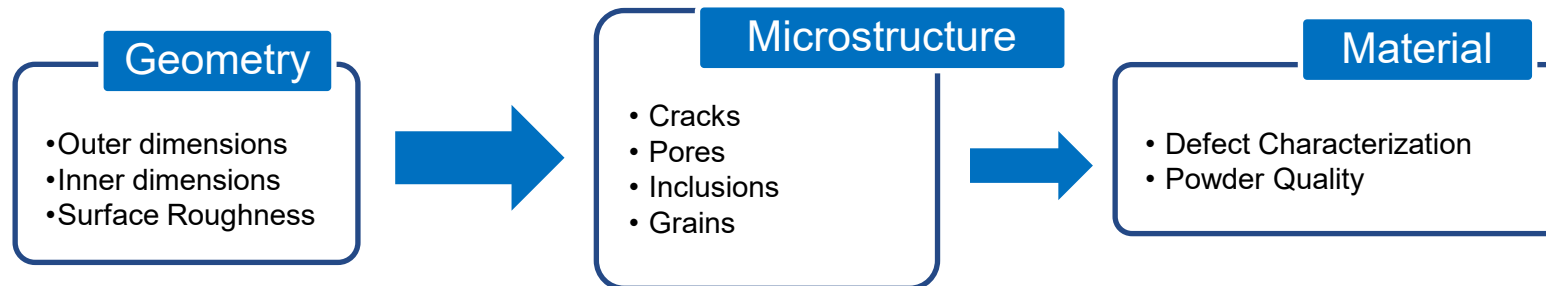
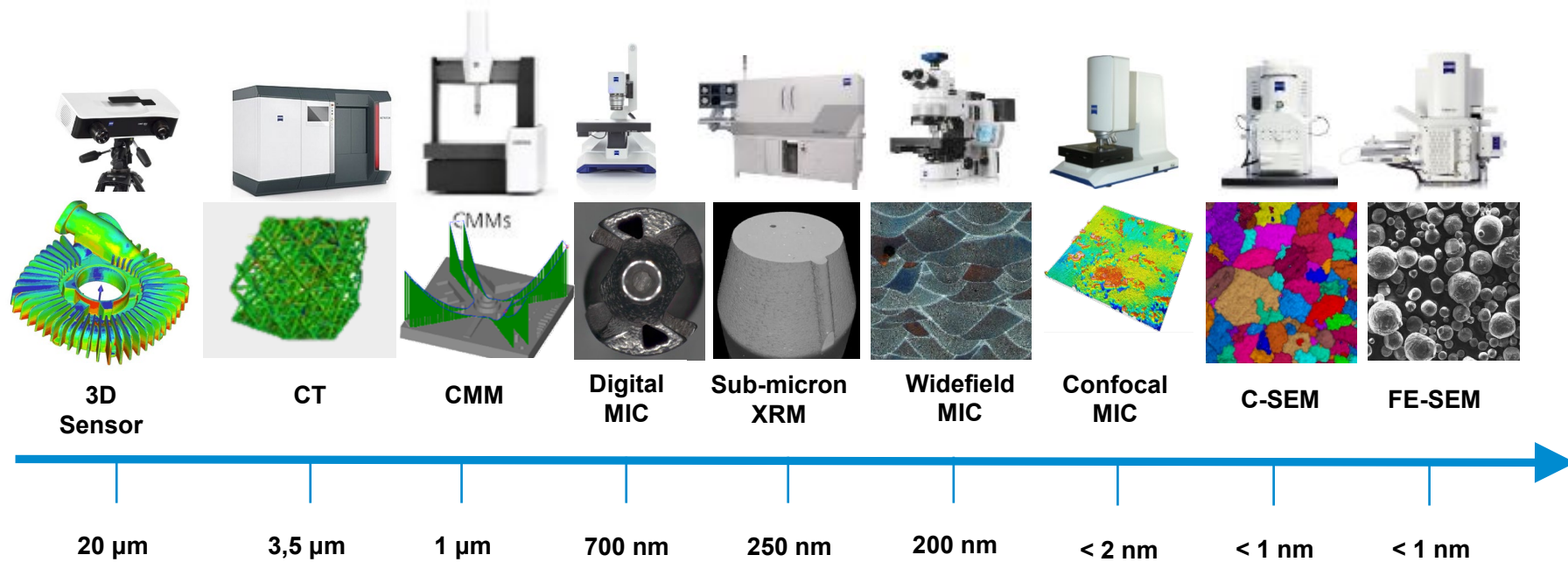
ZEISS Global Graduate Program

Setting things in motion as a team

[Read more](#)

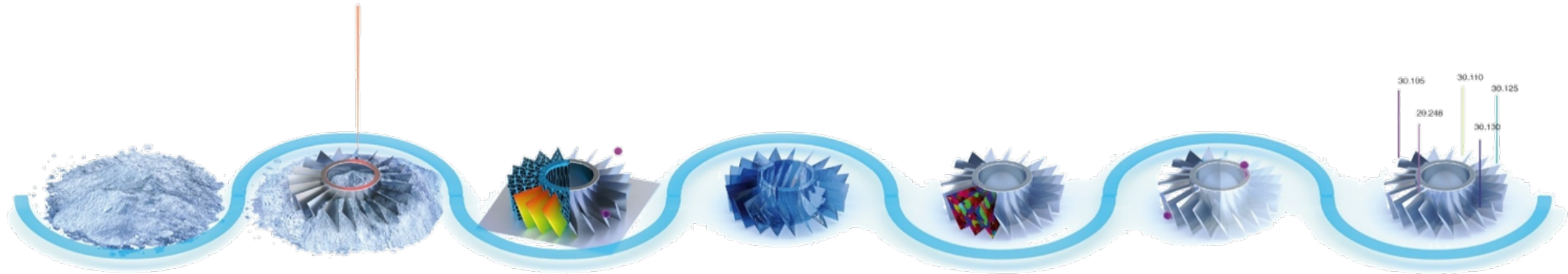
ZEISS Solution Portfolio for AM

Industry Leading Quality Control Portfolio from μm to nm



ZEISS Blue Line

The holistic integrated process for Additive Manufacturing



Powder and Material Characterization

SEM, LM, X-ray CT



In-Process Metrology and Data Analysis

Powder Bed Inspection



Post-Print Heat Treatment and Part Removal

CMM, 3D Scanning



Defect and Inner Structure Inspection

X-ray CT, LM



Post-Print Material Quality Inspection

SEM, LM, X-ray CT



Dimensional and Surface Quality Inspection

CMM, X-ray CT, 3D Scanning, LM

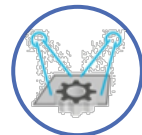


Process Data Statistics and Analytics

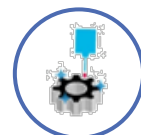
PiWeb, Analytics and Correlation Tools



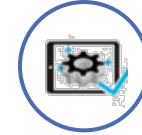
Light Microscopy (LM)



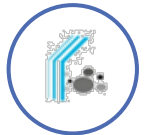
In-process monitoring



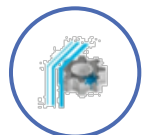
High precision measurement with CMM



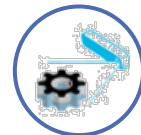
Metrology & analysis software



Scanning electron microscopy (SEM)



Computer tomography & X-Ray microscopy



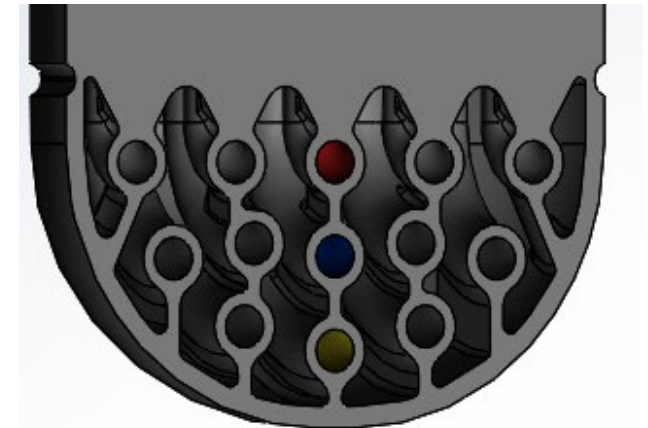
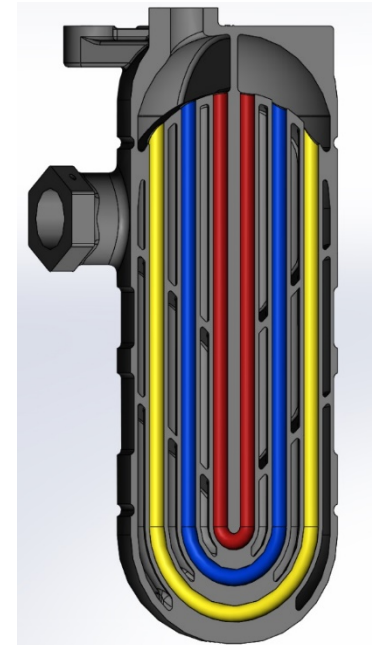
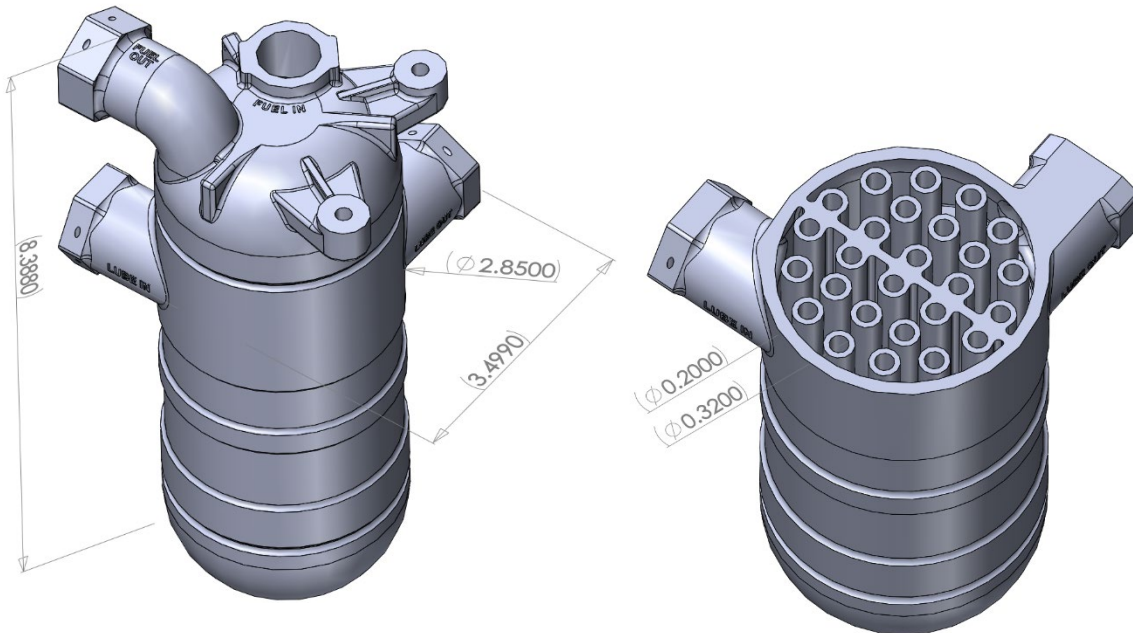
3D scanning

Case Study

AM Heat exchanger for Air Force Sustainment



- Fuel cooled oil coolers (FCOC) are utilized on nearly every powerplant in the DoD fleet for cooling of turbine oil and pre-heating fuel. These heat exchangers have become a sustainment problem due to high replacement part cost, long lead times, and ever- increasing replacement volume due to the number of aging powerplants.
- As part of an ongoing America Makes program UDRI and team are seeking to enable AM replacement of these oil coolers



Fabrication



Correlative Measurement on Heat Exchanger

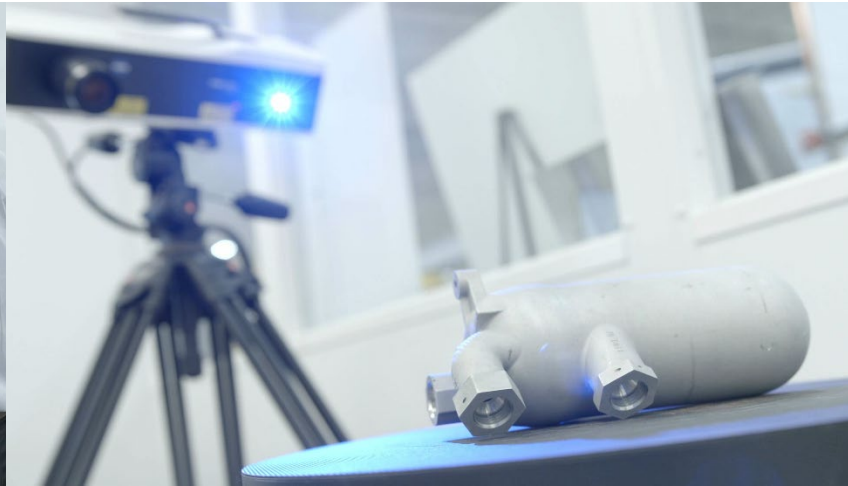
ZEISS AM Characterization Center



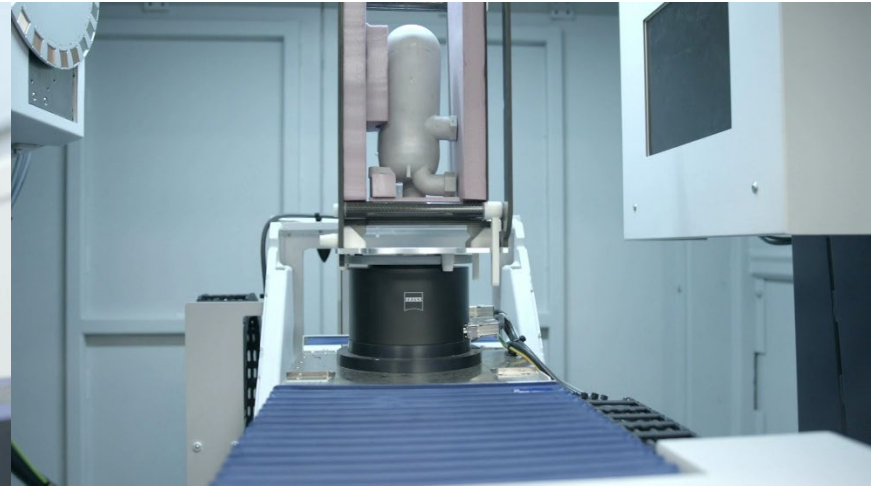
CMM (Duramax)



3D Scanner (GOM Scan1)



X-ray CT (Metrotom 800 HR)



Micro-CT (Versa 620)



Light Microscope (Axio Imager & Smartproof)



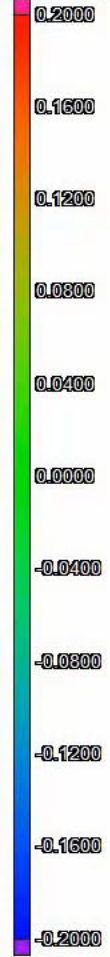
SEM (Evo 15 & Crossbeam 550)





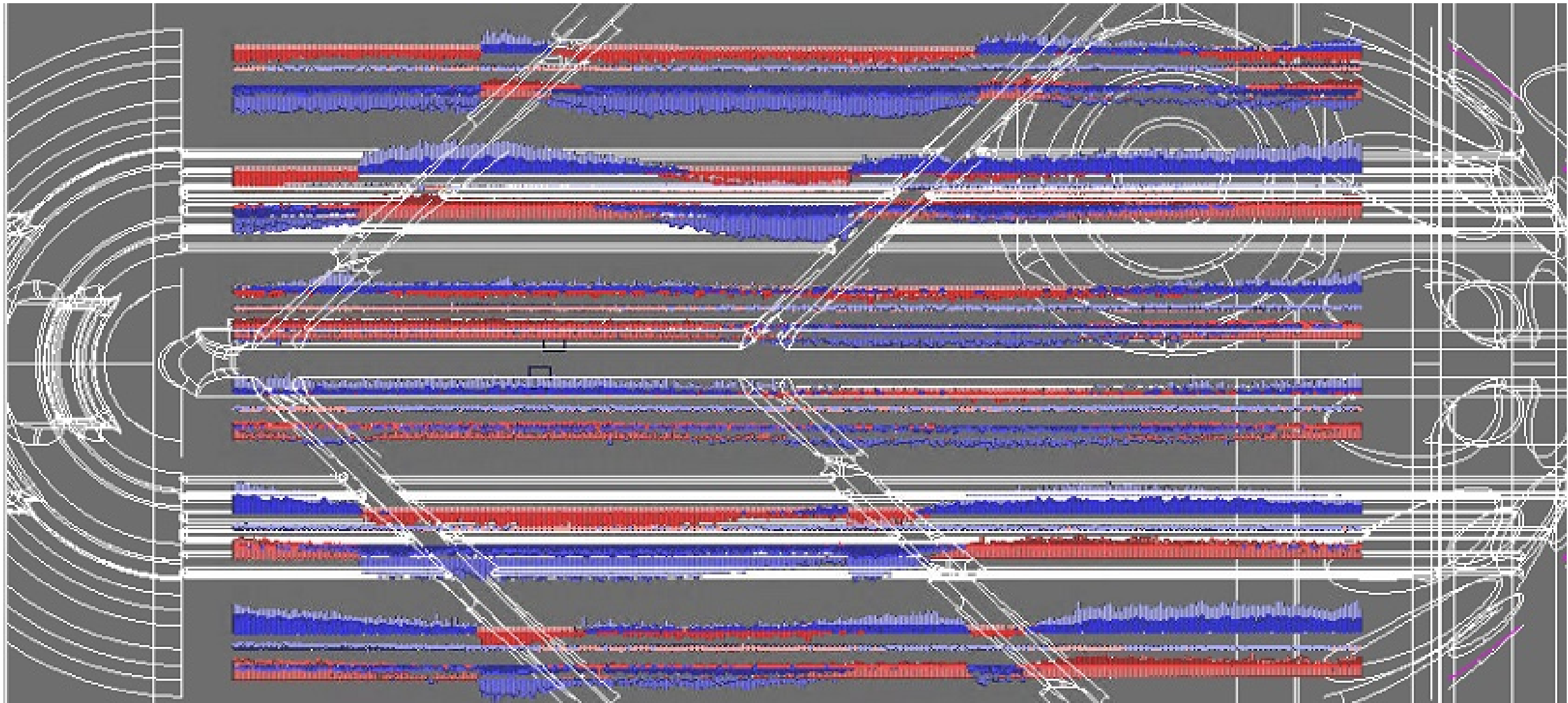
Seeing beyond

Deviation [mm]



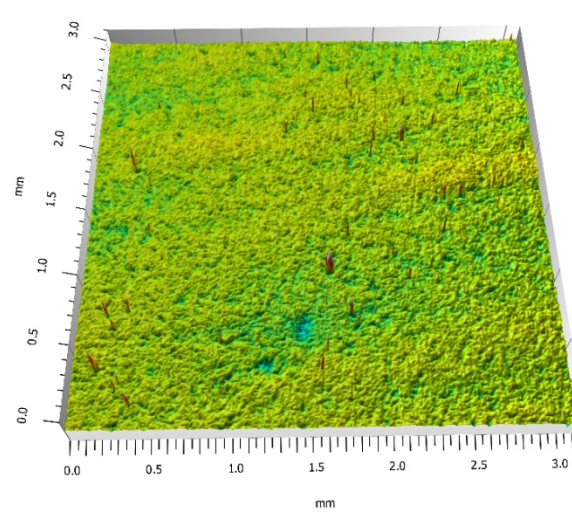
Actual vs Nominal Metrology Comparison

CT



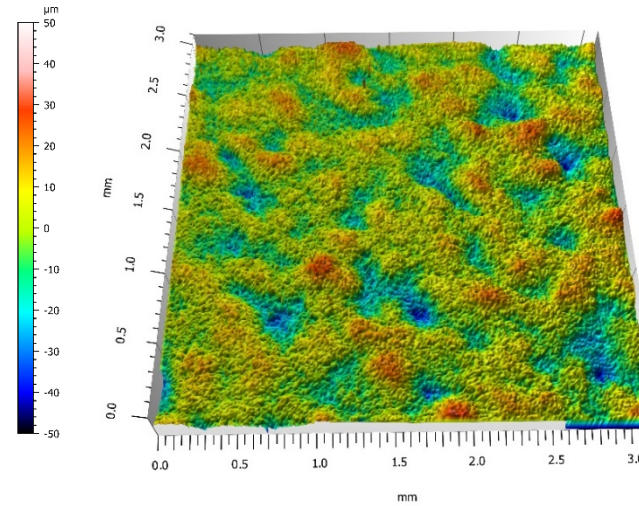
Non-destructive Surface Quality Measurement

Confocal (External) & X-ray (Internal) microscopy



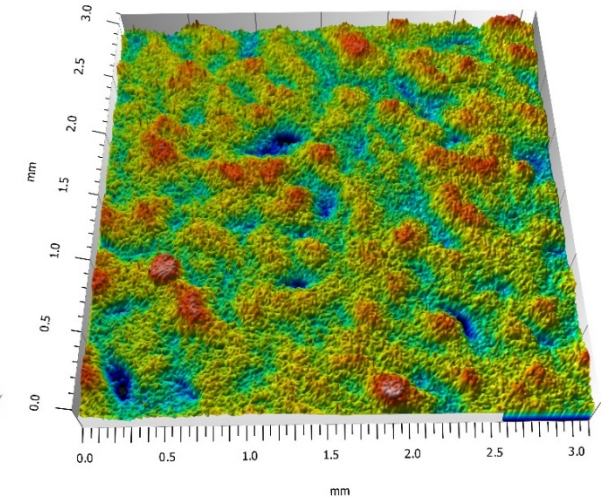
ISO 4287		
Amplitude parameters ...		
Rp	5.184	μm
Rv	5.318	μm
Rz	10.50	μm
Rc	4.066	μm
Rt	17.05	μm
Ra	1.508	μm
Rq	1.933	μm
Rsk	-0.1913	
Rku	3.661	

ISO 25178		
Height Parameters		
Sq	4.627	μm
Ssk	-7.307	
Sku	331.6	
Sp	137.5	μm
Sv	286.5	μm
Sz	423.9	μm
Sa	2.790	μm



ISO 4287		
Amplitude parameters - R...		
Rp	10.50	μm
Rv	12.36	μm
Rz	22.86	μm
Rc	7.174	μm
Rt	30.63	μm
Ra	2.679	μm
Rq	3.475	μm
Rsk	-0.5899	
Rku	3.937	

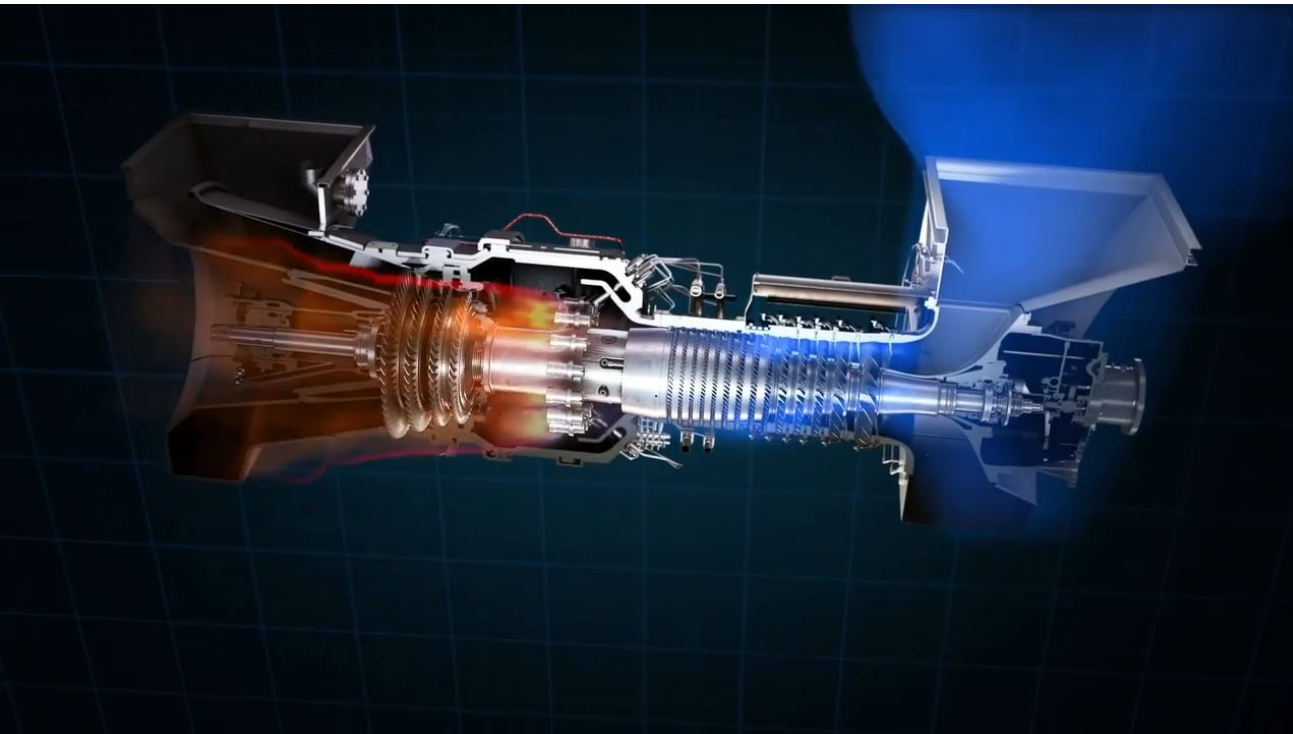
ISO 25178		
Height Parameters		
Sq	10.38	μm
Ssk	-0.4719	
Sku	3.580	
Sp	75.60	μm
Sv	137.2	μm
Sz	212.8	μm
Sa	8.171	μm



ISO 4287		
Amplitude parameters ...		
Rp	14.20	μm
Rv	23.16	μm
Rz	37.36	μm
Rc	11.17	μm
Rt	68.30	μm
Ra	3.587	μm
Rq	4.874	μm
Rsk	-0.791	
Rku	7.408	

ISO 25178		
Height Parameters		
Sq	12.55	μm
Ssk	-0.2286	
Sku	4.008	
Sp	115.7	μm
Sv	143.4	μm
Sz	259.1	μm
Sa	9.773	μm

Improving Efficiency of Gas Turbine Using AM



Efficiency of most modern gas turbines for power generation is between 60–64%

Using AM, novel designs can be produced to improve efficiency beyond the 64% limit

Advantage: Design iteration time is fast, or the order of weeks/months compared to 2–3 years

Disadvantage: IN738 alloy used for gas turbine application is not weldable crack-prone, which makes the print AM parameter development challenging

Collaboration partners to research and print, analyze for quality control, and test in real gas turbine

- Solar Turbines,
- MDF-ORNL and
- ZEISS

Inconel 738 Turbine Blades Inspection using ZEISS Blueline for AM

Correlative Multi-resolution Imaging (CT, XRM & SEM)



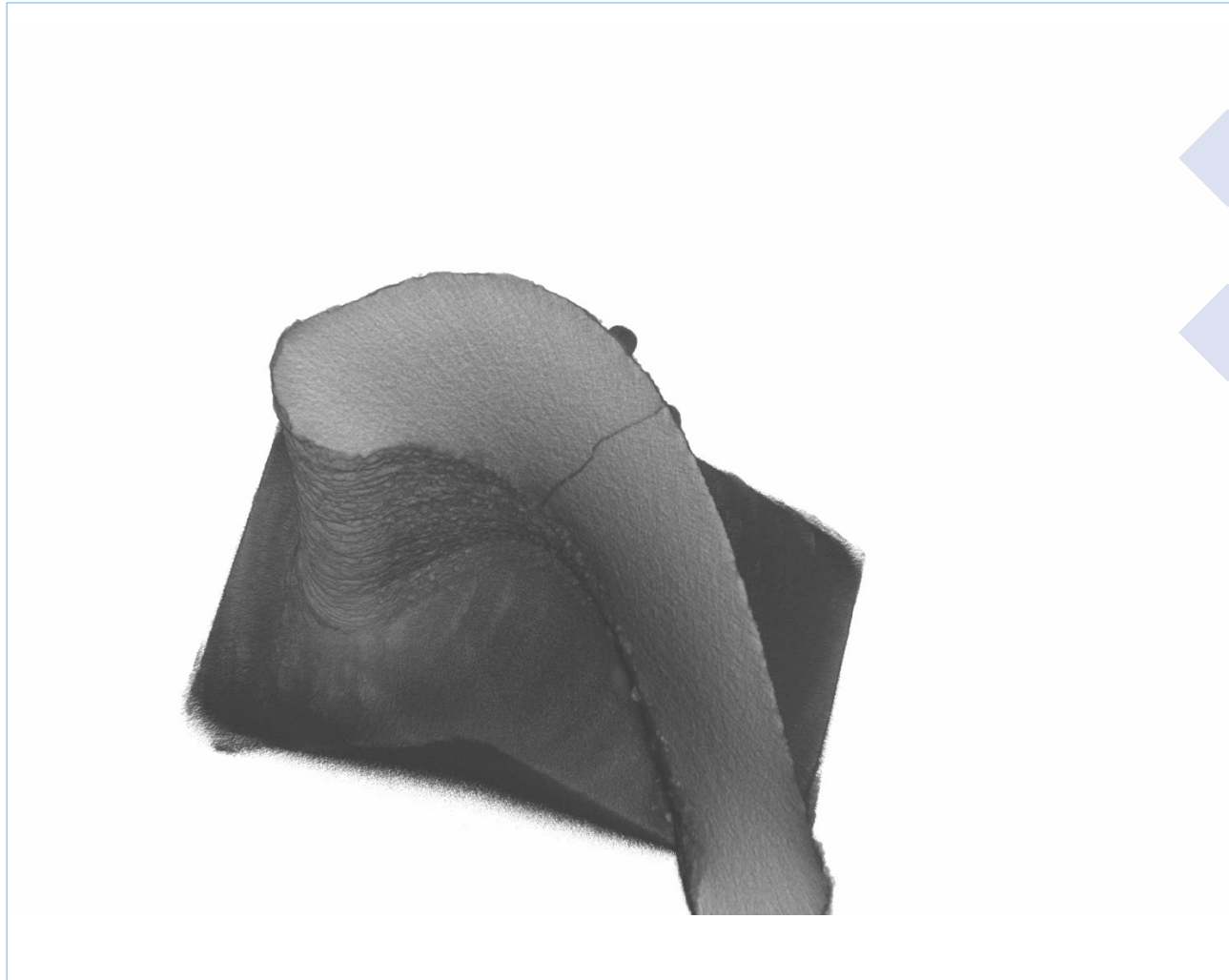
Crack in blade detected in routine scan

Voxel
size

[38 μ m]

Inconel 738 Turbine Blades Inspection using ZEISS Blueline for AM

Correlative Multi-resolution Imaging (CT, XRM & SEM)



Crack in blade detected in routine scan

Voxel
size

[38 μ m]

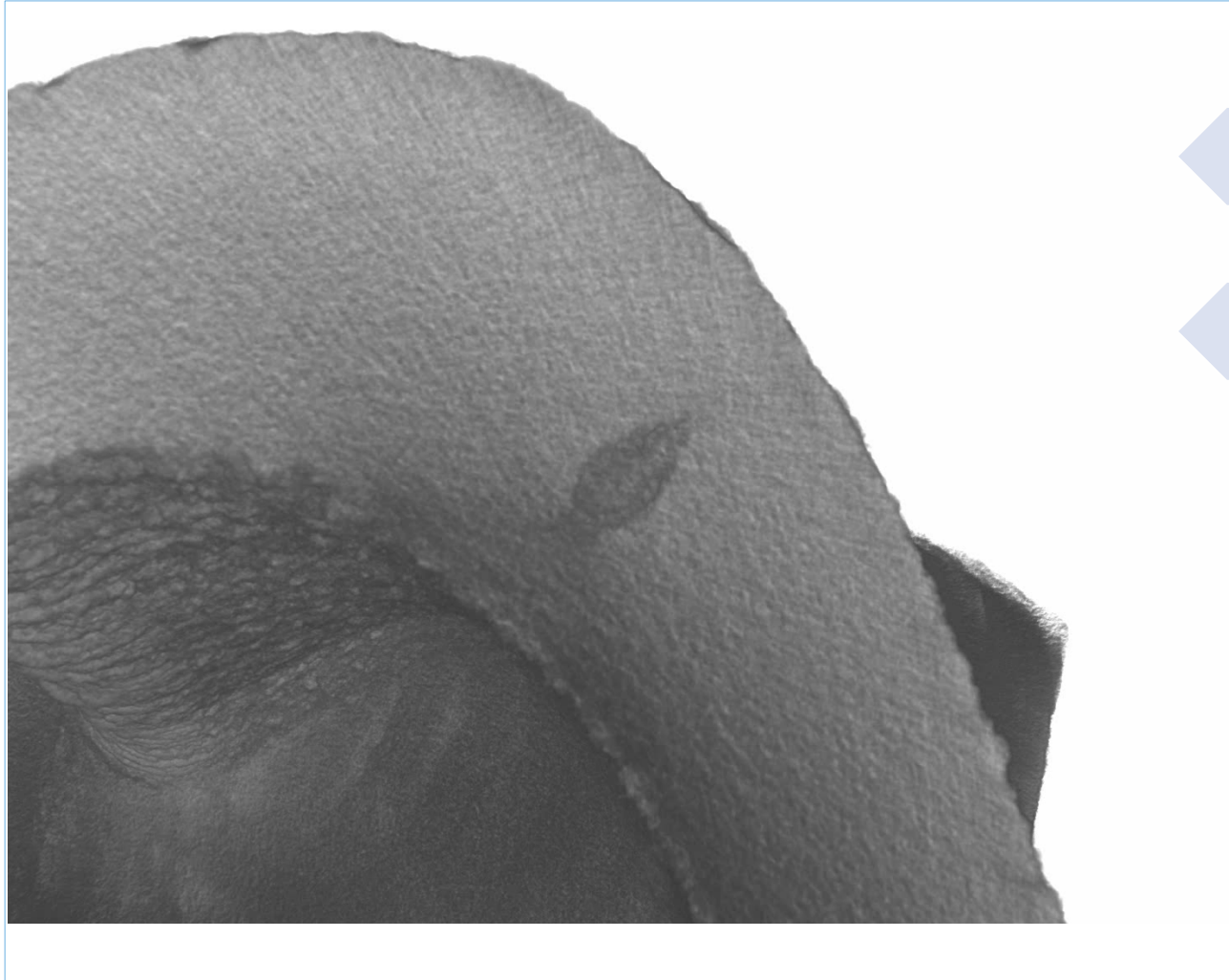


Origin of the crack is a pocket in the material

[18 μ m]

Inconel 738 Turbine Blades Inspection using ZEISS Blueline for AM

Correlative Multi-resolution Imaging (CT, XRM & SEM)



Crack in blade detected in routine scan

Voxel
size

[38 μ m]

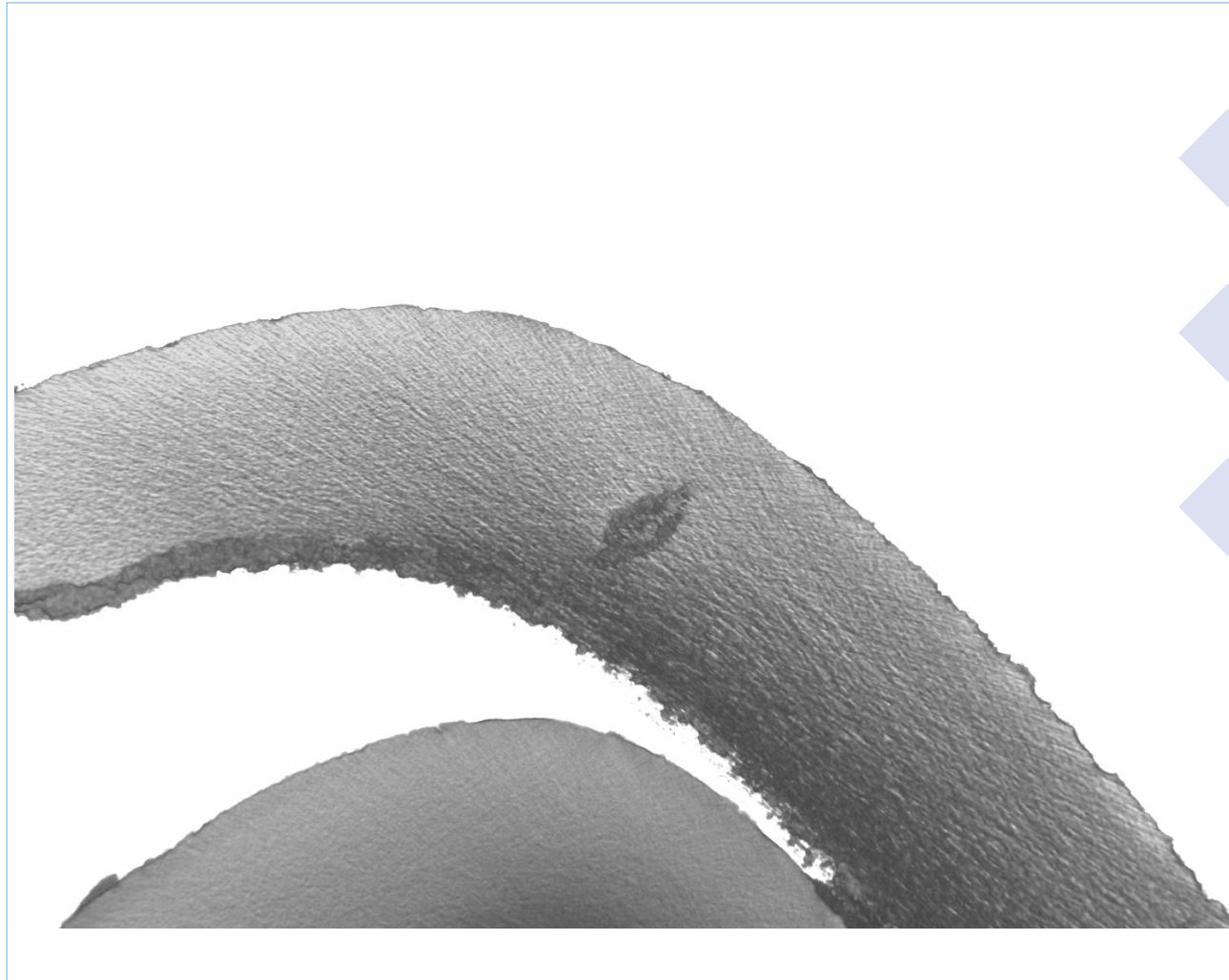


Origin of the crack is a pocket in the material

[18 μ m]

Inconel 738 Turbine Blades Inspection using ZEISS Blueline for AM

Correlative Multi-resolution Imaging (CT, XRM & SEM)



Crack in blade detected in routine scan

Voxel
size

[38 μ m]

Origin of the crack is a pocket in the material

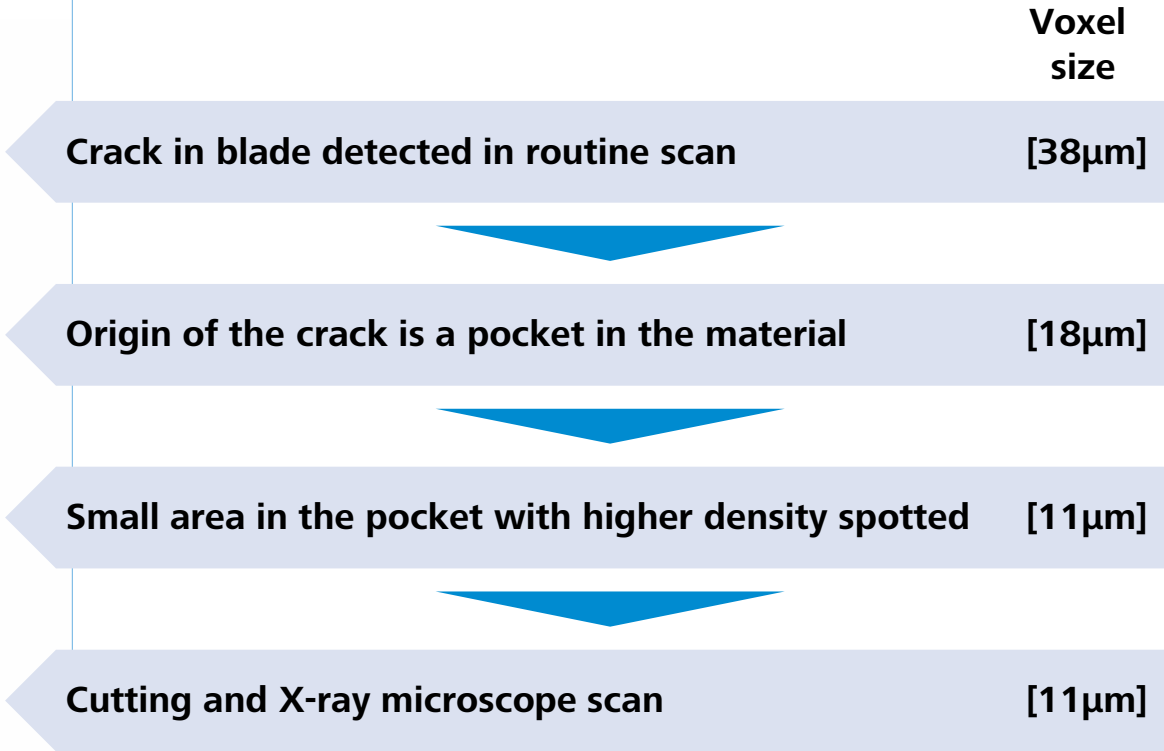
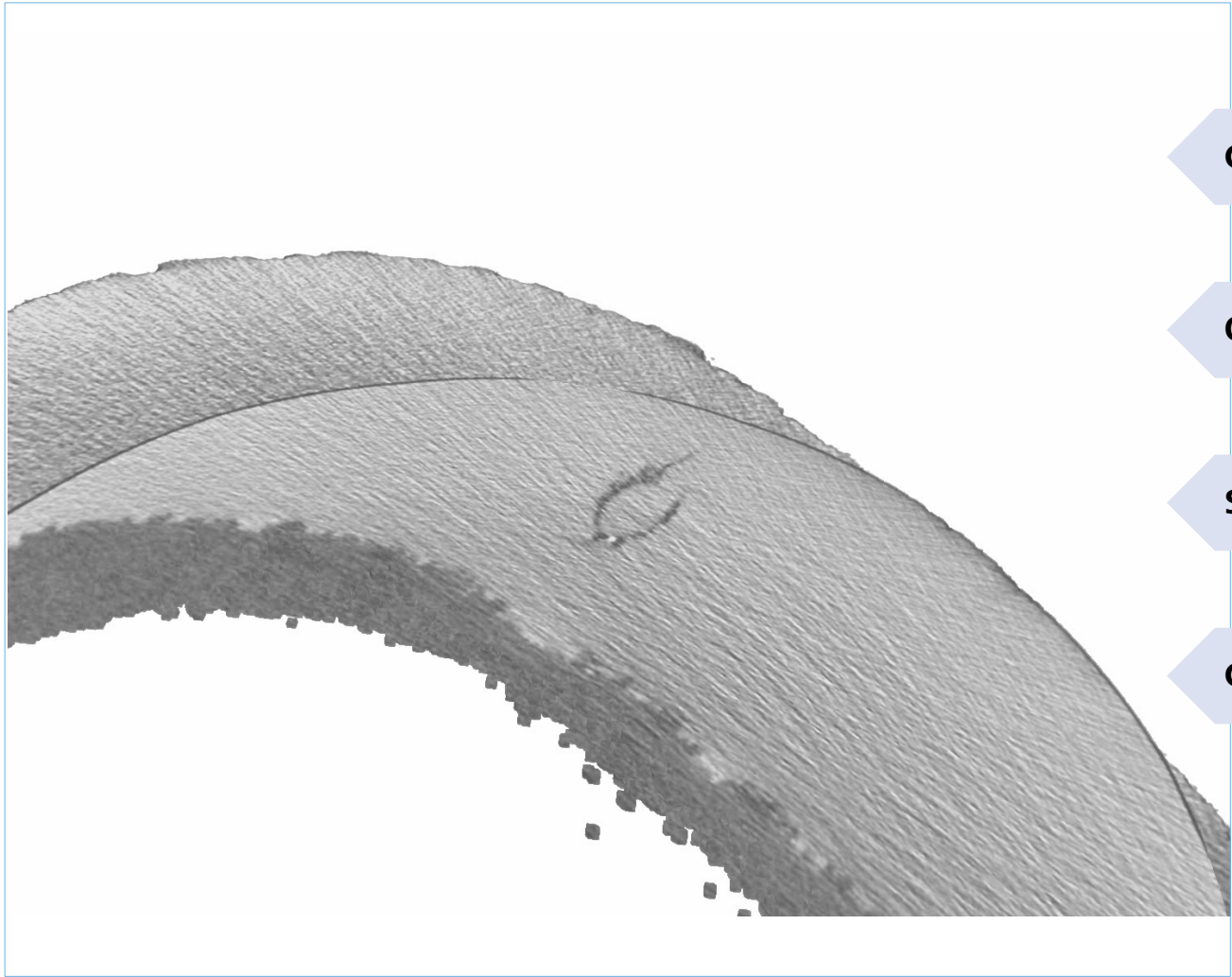
[18 μ m]

Small area in the pocket with higher density spotted

[11 μ m]

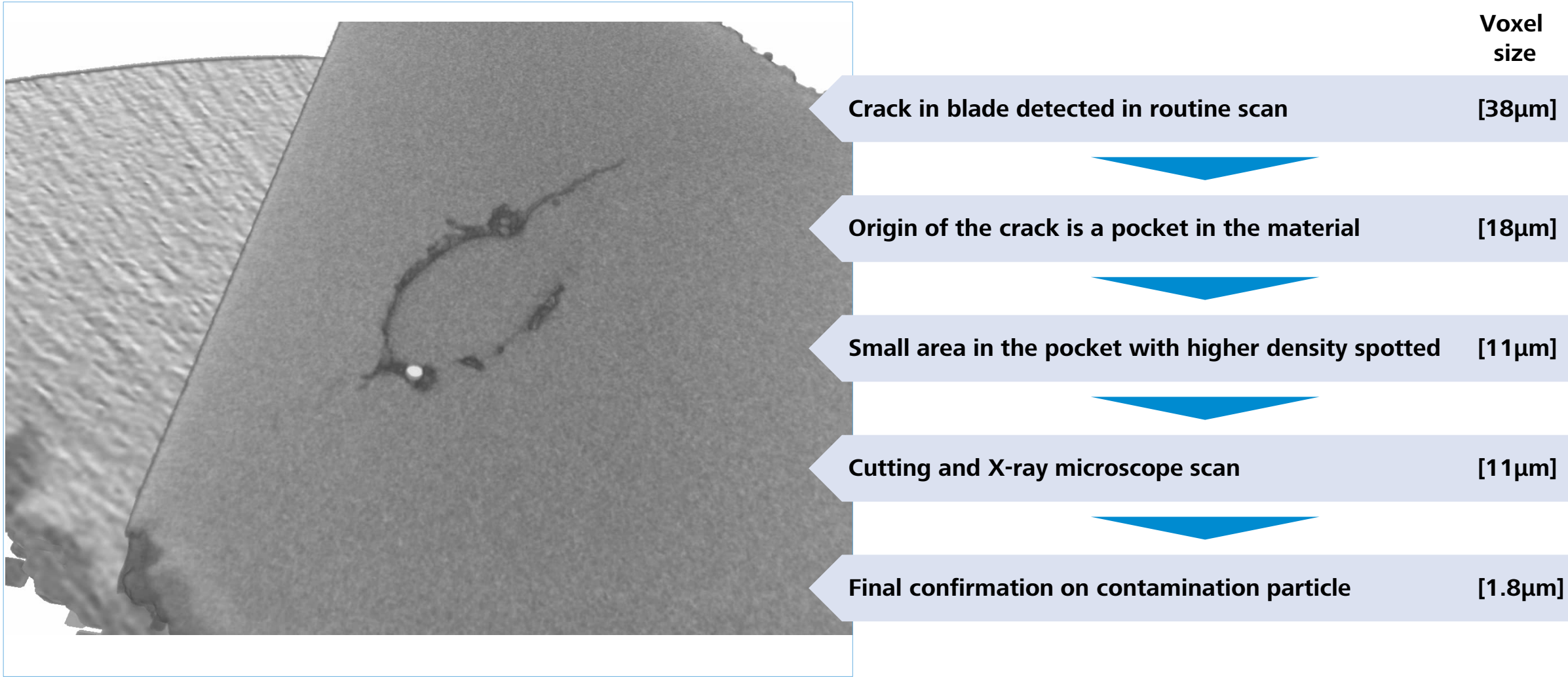
Inconel 738 Turbine Blades Inspection using ZEISS Blueline for AM

Correlative Multi-resolution Imaging (CT, XRM & SEM)



Inconel 738 Turbine Blades Inspection using ZEISS Blueline for AM

Correlative Multi-resolution Imaging (CT, XRM & SEM)

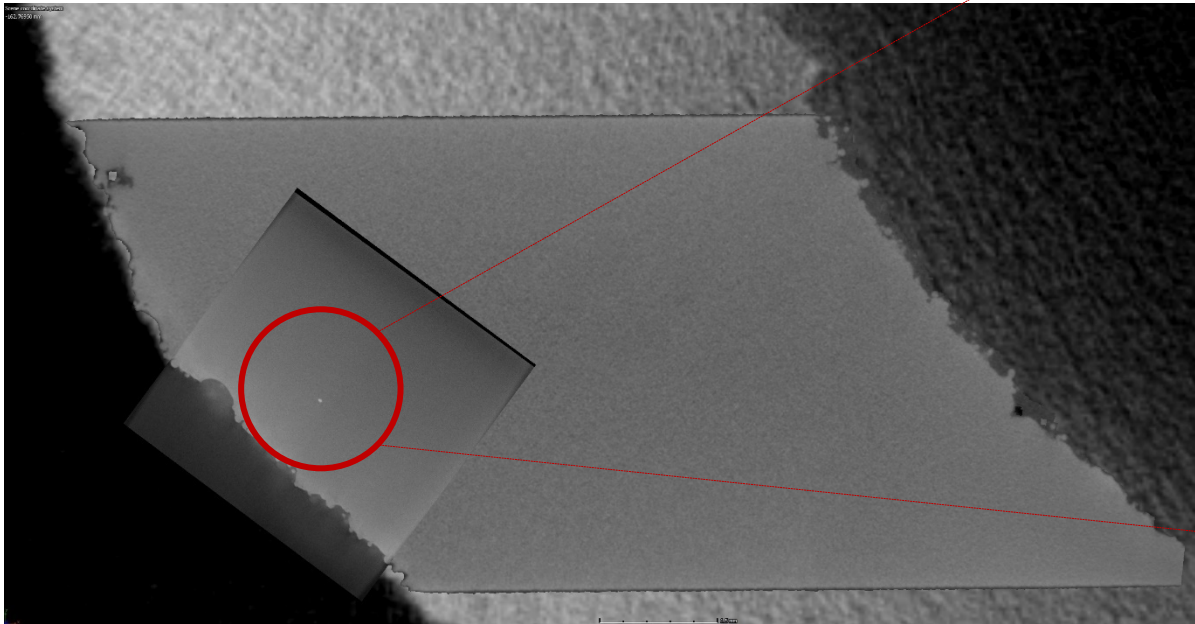


Inconel 738 Turbine Blades Inspection using ZIESS Blueline for AM

Correlative Multi-resolution Imaging (CT, XRM & SEM)

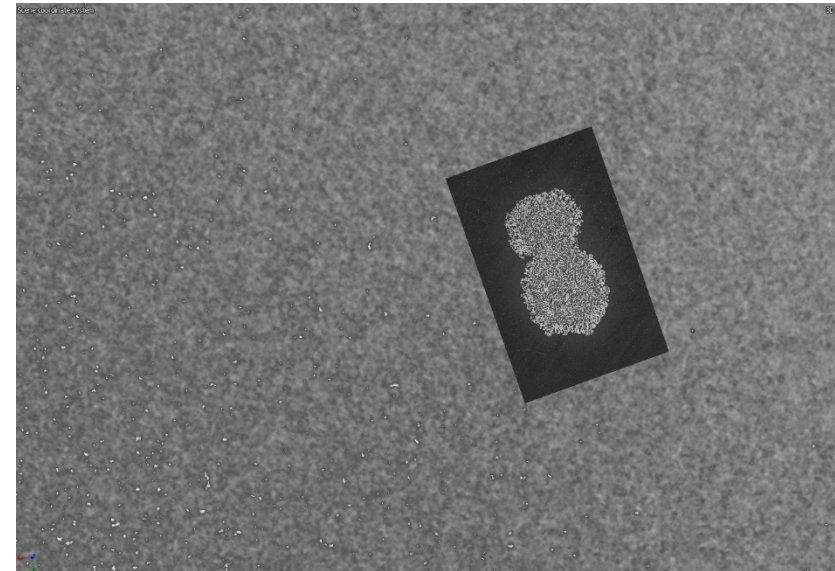
Navigation to ROI between several tools

X-ray microscope image



Assessment of identified contaminant

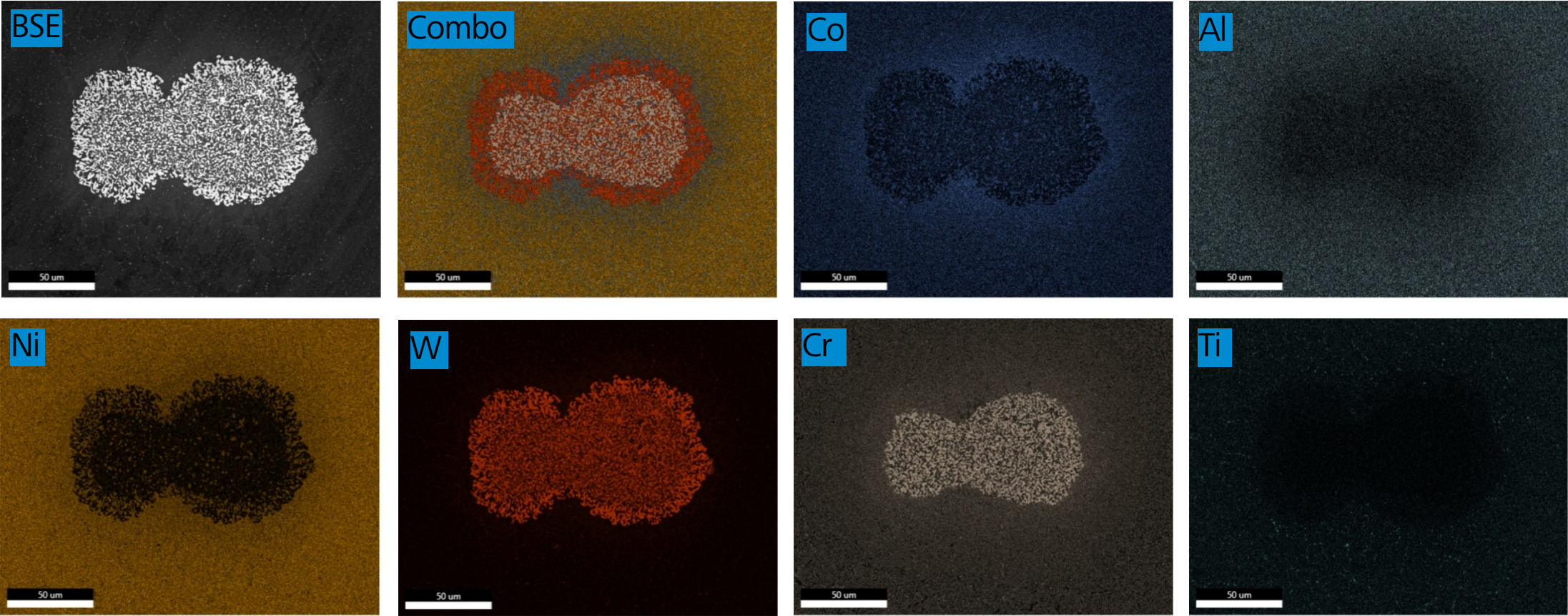
SEM Analysis



- BSE Image from ZEISS Crossbeam 550
- Similar to X-ray, dark areas are low density, bright areas are higher density

Inconel 738 Turbine Blades Inspection using ZIESS Blueline for AM

Correlative Multi-resolution Imaging (CT, XRM & SEM)



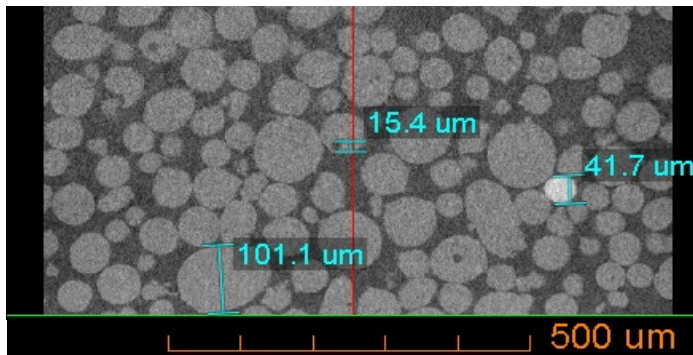
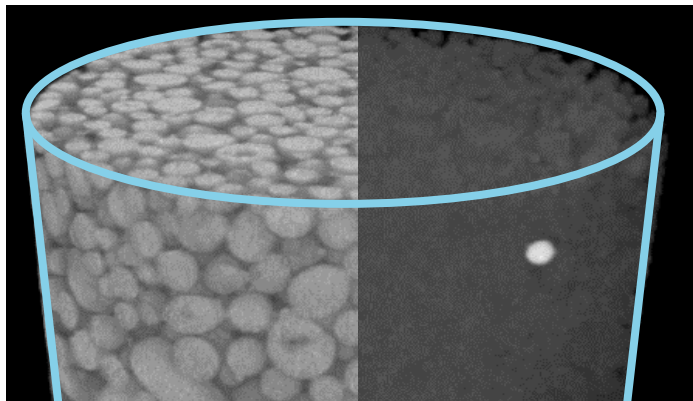
Contaminant particle is composed of Tungsten, Chromium

Inconel 738 Turbine Blades Inspection using ZIESS Blueline for AM

Correlative Multi-resolution Imaging (CT, XRM & SEM)

Surface

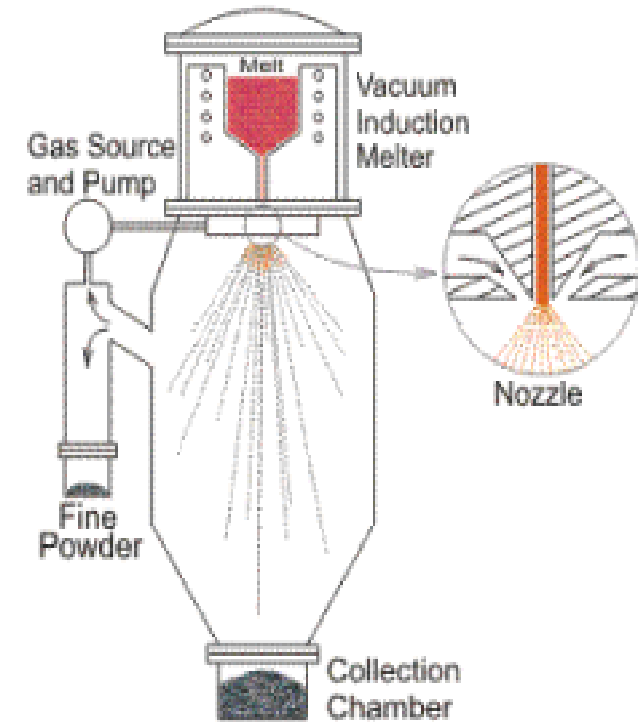
Density



Cross-section

Atomization of powder can introduce contamination into the build. Nozzles, electrical filaments and other high stress components are generally made of Tungsten. This material can break off in aging equipment and deposit itself in the resulting powder.

We believe this to be the source of contamination in the final material.



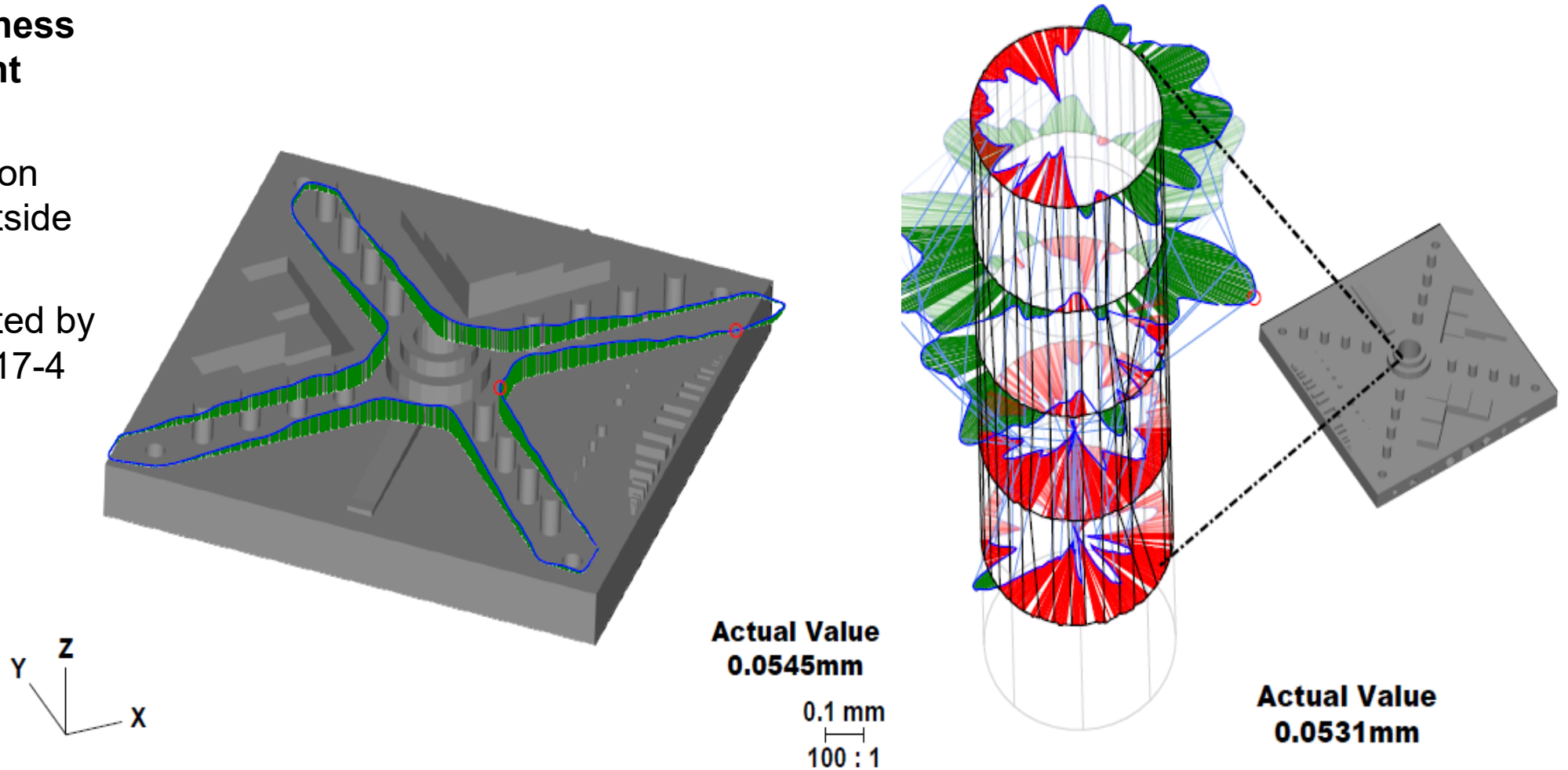
Vertical Gas Atomizer: Source "Powder Metallurgy Science" Second Edition, R.M. German, MPIF.

Heat Treatment effects — NIST Artefact

As Built (CMM + PiWeb)

Evaluation of flatness of the artifact right after build up

- Maximum deviation from inside to outside is 0.055 mm
- Artifact was created by EOS GP1 using 17-4 stainless steel

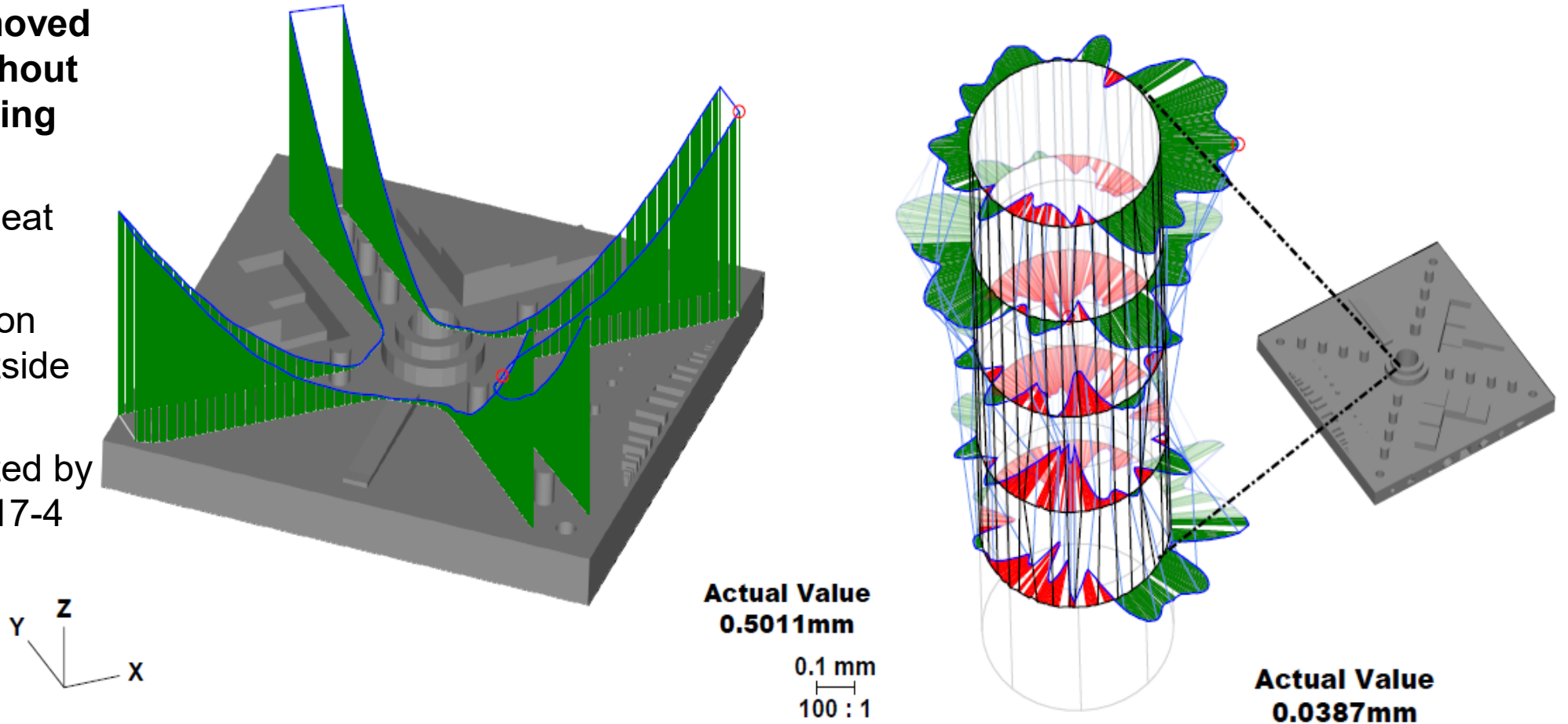


Heat Treatment effects — NIST Artefact

Before Heat Treatment and Removed from Build Plate (CMM + PiWeb)

Evaluation of flatness of the artifact removed from the base without heat treatment using WEDM

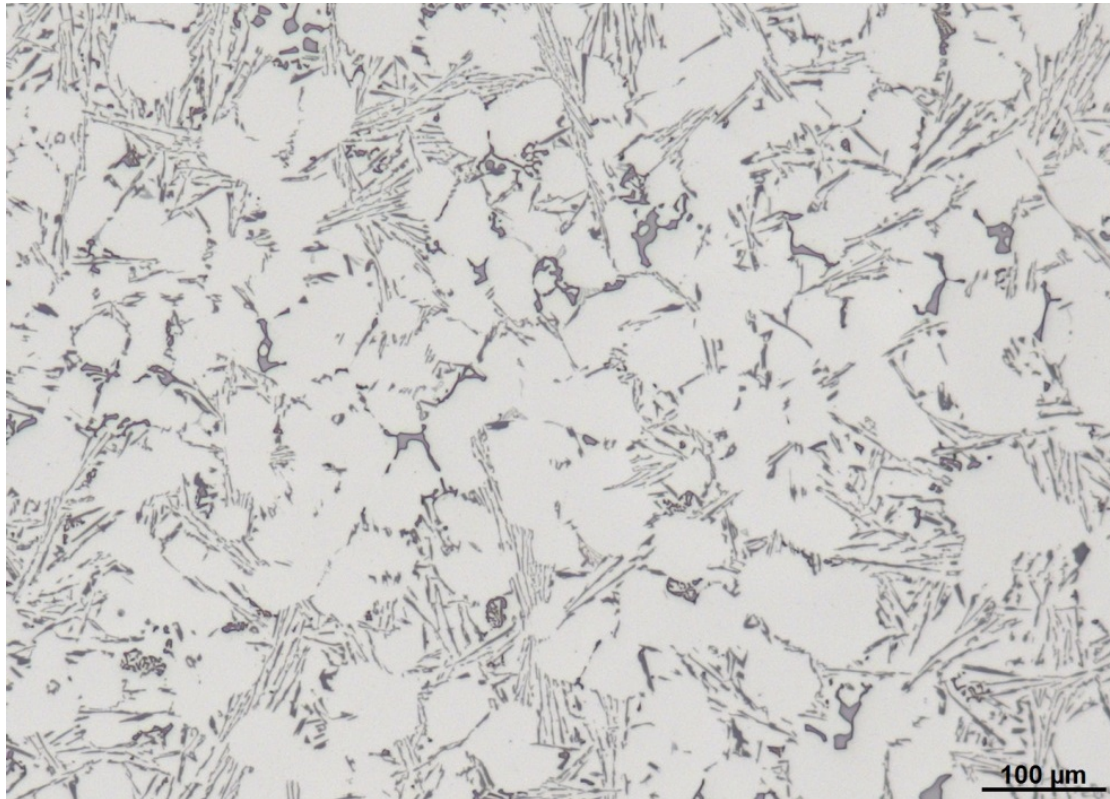
- Artifact was not heat treated
- Maximum deviation from inside to outside is 0.501 mm
- Artifact was created by EOS GP1 using 17-4 stainless steel



Analysis of Grain Structure

Comparison of Conventional and Additive (LM)

Conventional



AISi10Mg, conventional, polished
Axiolmager.Z2m, BF, 100x

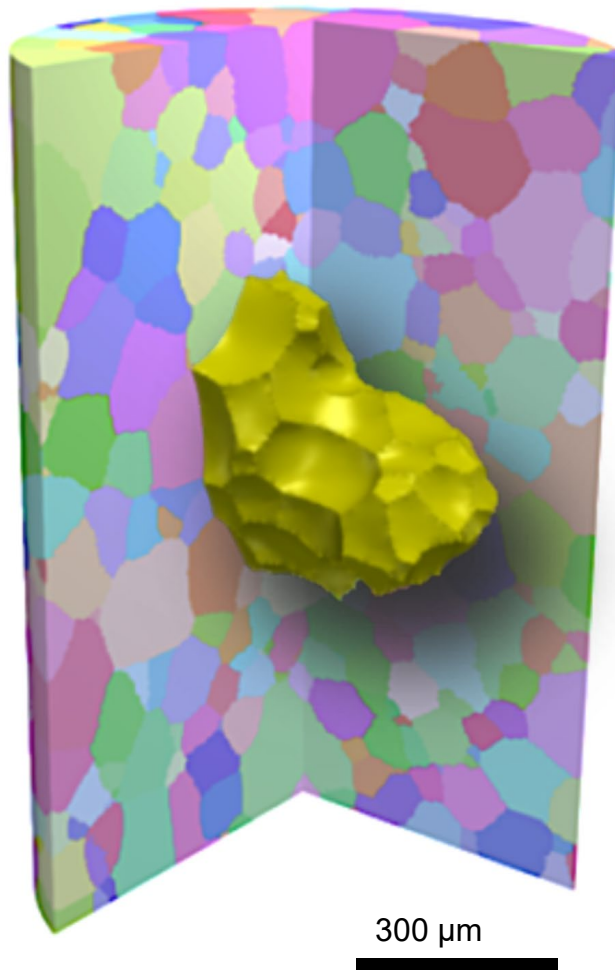
AM Printed



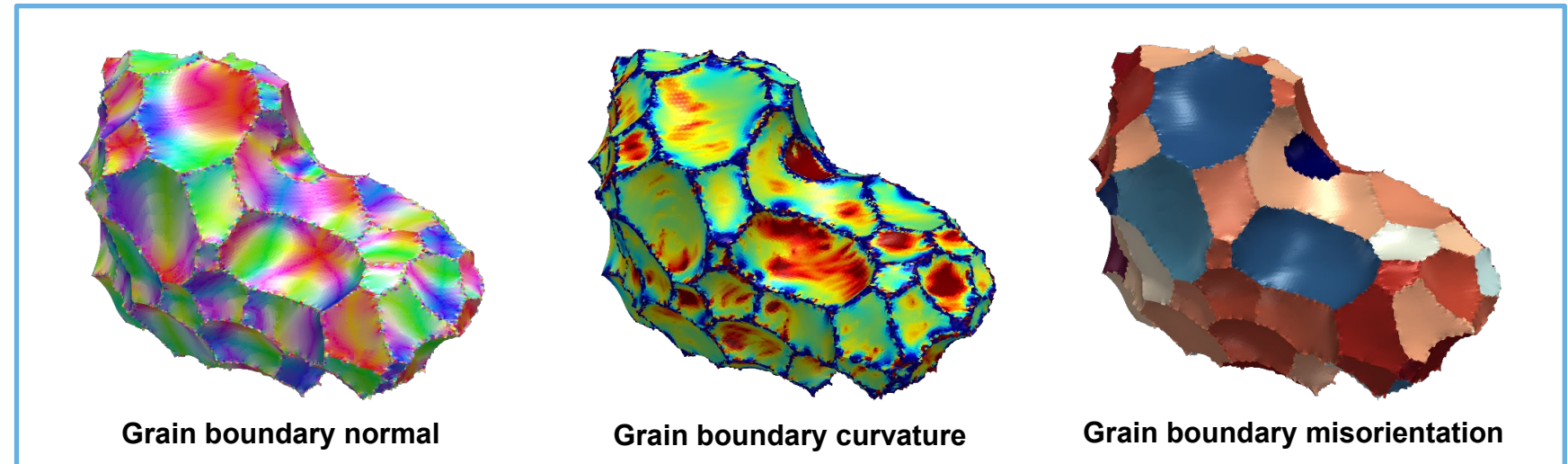
AISi10Mg, SLM, polished, Si is dispersed.
Axiolmager.Z2m, BF, 500x

Non-destructive Grain Structure Characterization

Annealing and Grain Growth (XRM, LabDCT)



- Abnormal grain growth can lead to anomalous properties
- Diffraction contrast tomography (LabDCT) measures morphology and crystallography of grain structures in 3D
- Grain boundary characterization (inclination, orientation, curvature) can be measured to understand grain growth behavior
- 4D analysis (3D + time) to observe evolution of grain structure through treatment

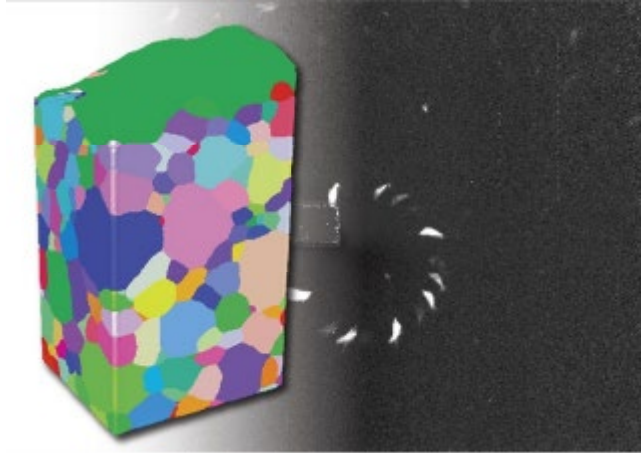


Application Examples

CrystalCT for a variety of sample sizes



SrTiO₃, 0.8x0.8x3.0 mm



Courtesy of Prof. A. Krause,
University of Florida, US

Armco iron, Ø=1.0 mm, h=3.1 mm



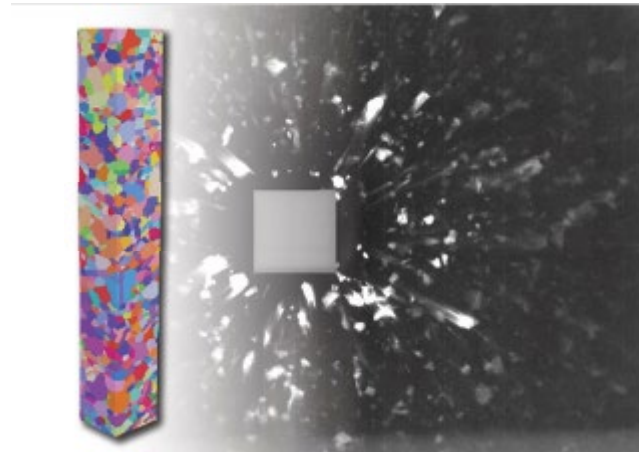
Courtesy of Prof. B.R. Patterson,
University of Florida, US

β-Ti alloy, 1.0x1.0x3.2 mm



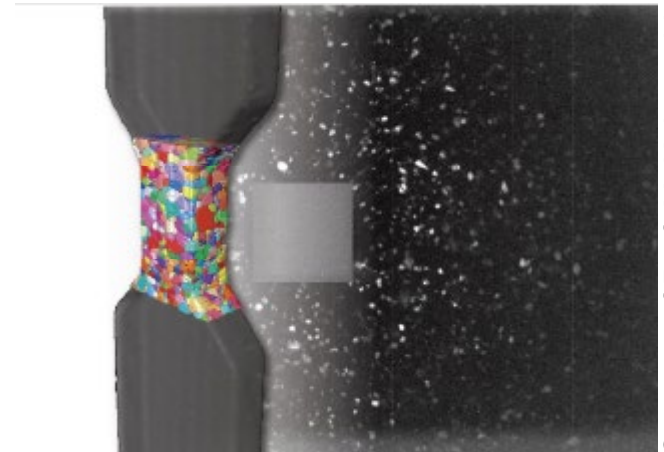
Courtesy of Prof. M. Kimura,
KEK, Japan

Carbon steel, 0.4x0.4x2.0 mm



Courtesy of Prof. G. Winther,
Technical University of Denmark

Stainless steel, 0.7x0.7x4.4 mm

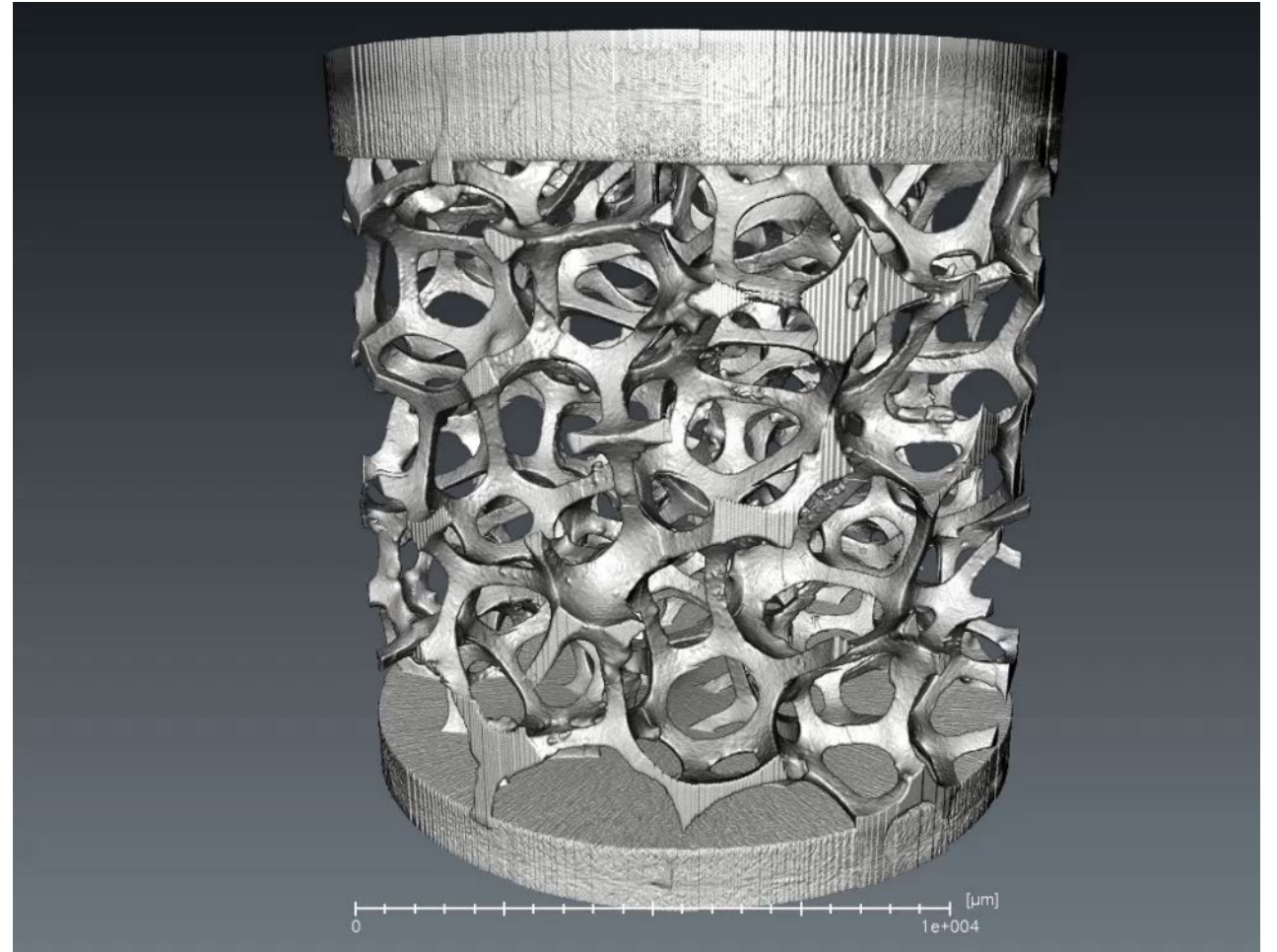


Courtesy of Prof. M. Kobayashi,
Toyohashi Univ. of Technol., Japan

Al-4wt%Cu, 1.3x1.0x0.5 mm

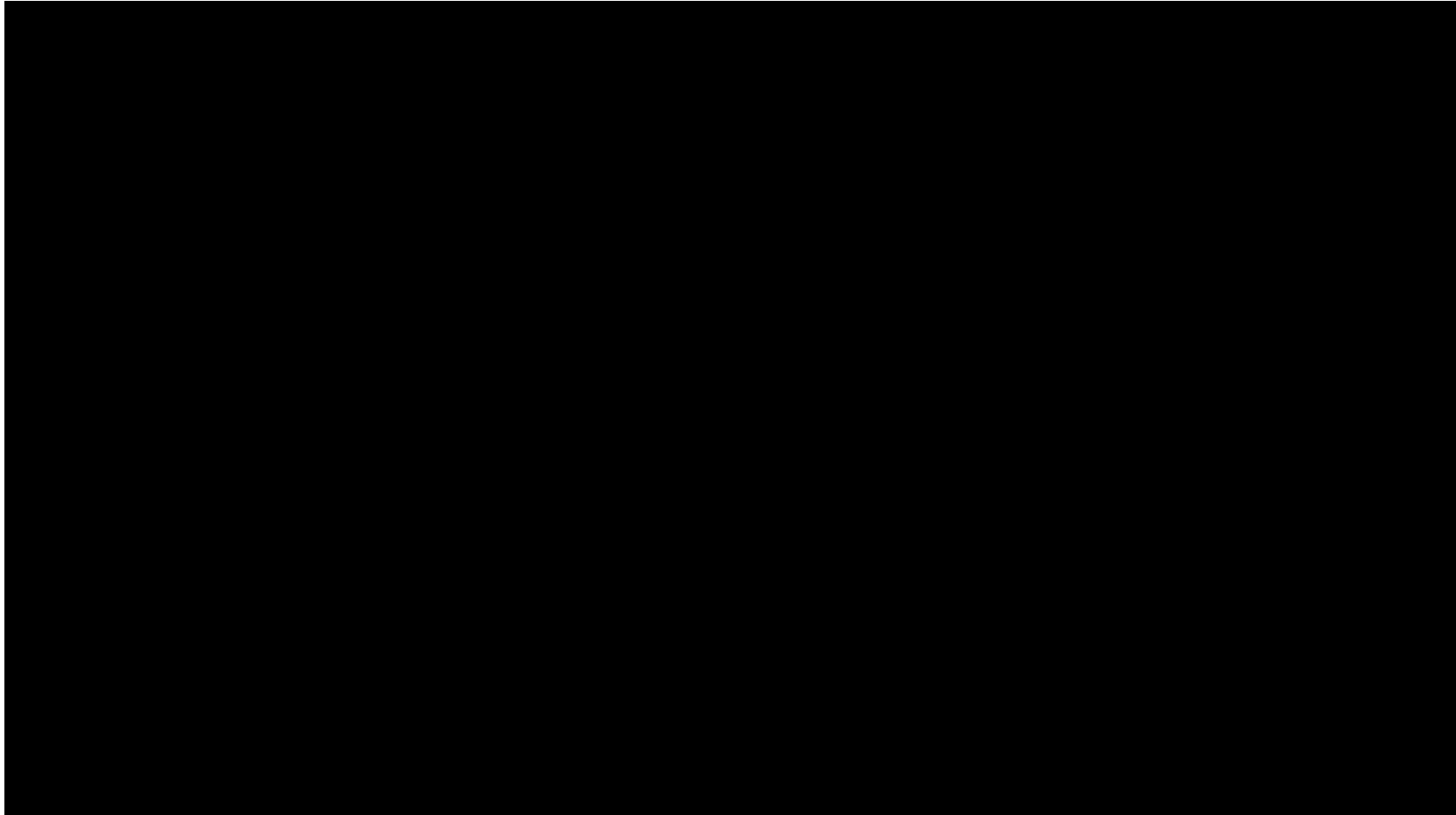
In-Situ Compression Testing

4D Imaging of Metal Foam (XRM with RaaD)



Material Testing

Measuring Surface Strain using GoM ARAMIS

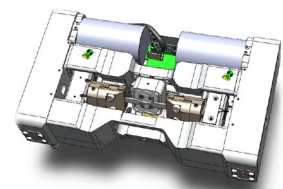


Integrated Nanoscale *In Situ* Microscopy

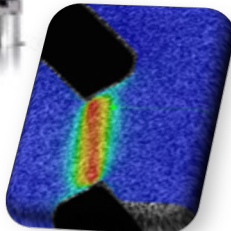
Using field emission SEM



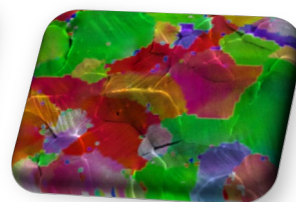
High Res Feature Tracking,
Auto Focus & Alignment



Heating and
mechanical load



Digital Image
Correlation



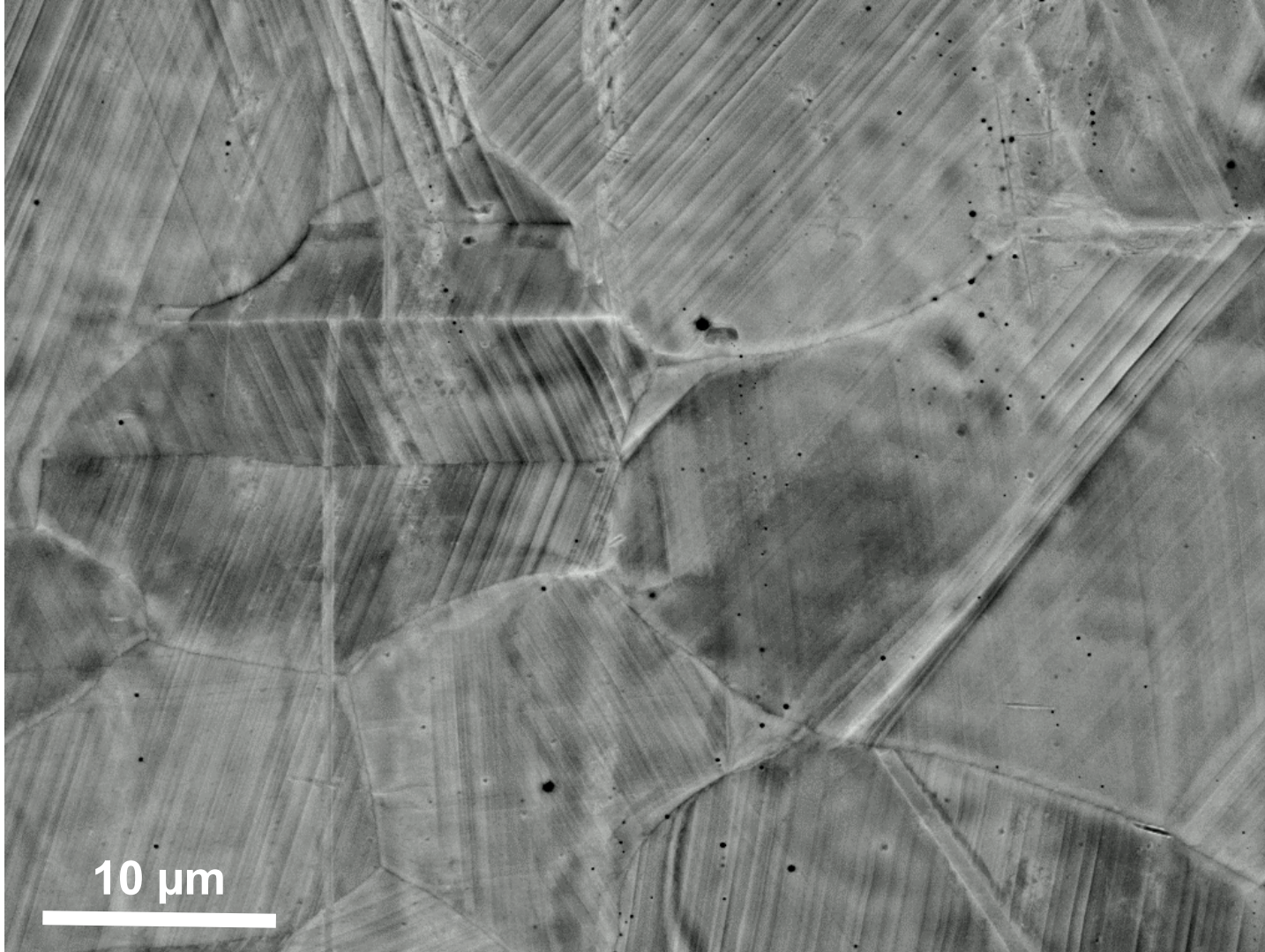
Automated
Analytics



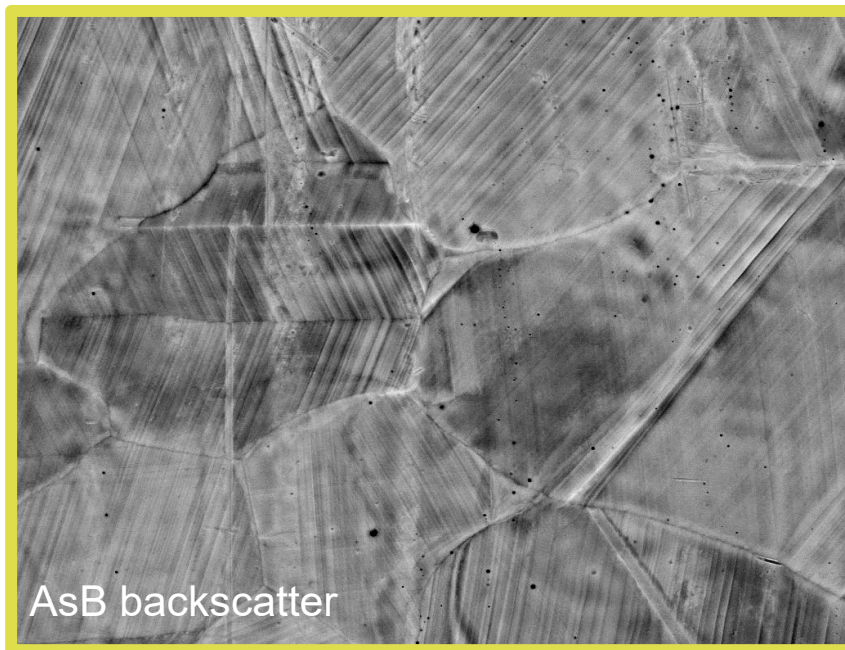
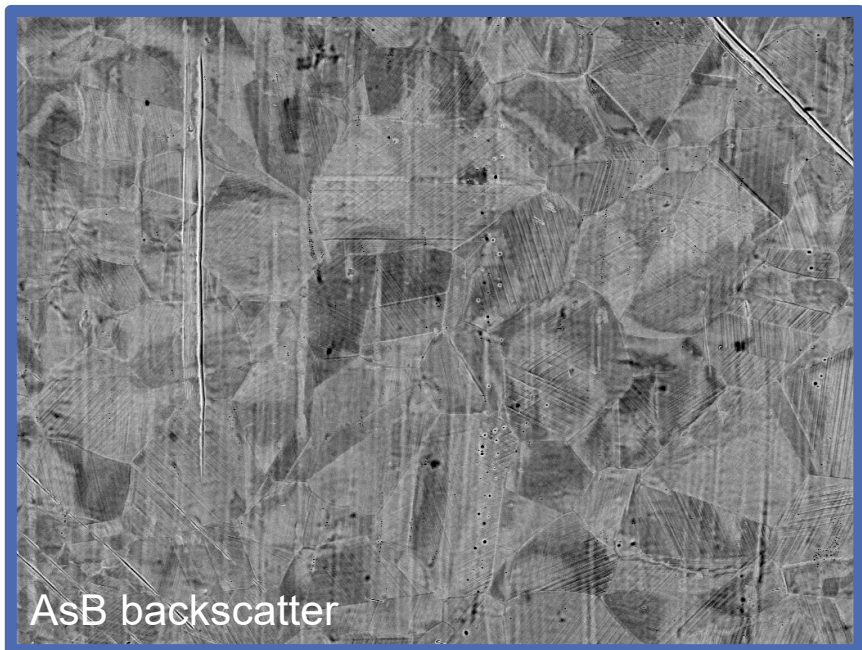
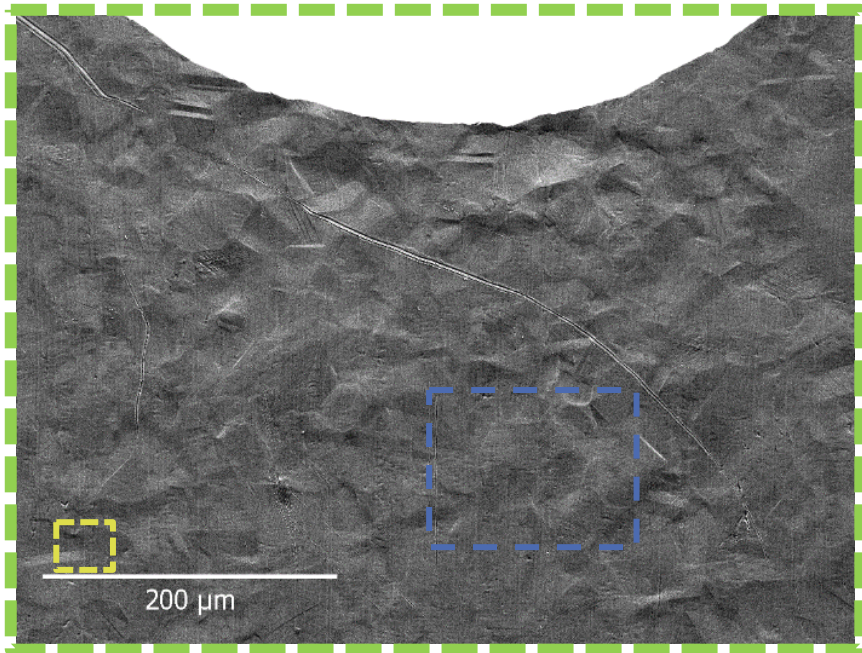
Complete sub-
system integration

***In Situ* Deformation and Heating in ZEISS SEM**

Imaging and tracking RoI's (automatically) at each deformation step



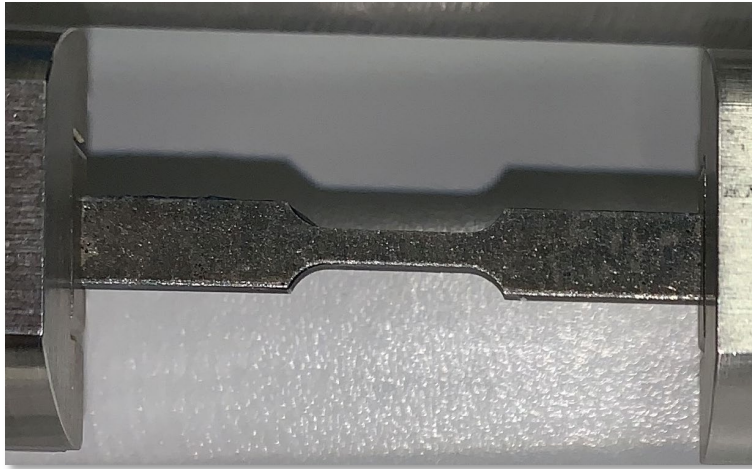
- Using automation and **feature tracking** it is possible to capture the material deformation at much smaller steps that are not practical to do manually.
- In this specific example, the development of material defects under deformation is imaged using BSE detector and **channeling contrast**.



Multiple ROI's can be tracked and imaged automatically during in situ experiments, each with their own location, beam conditions, magnification, and detector options

Haynes 282 Alloy

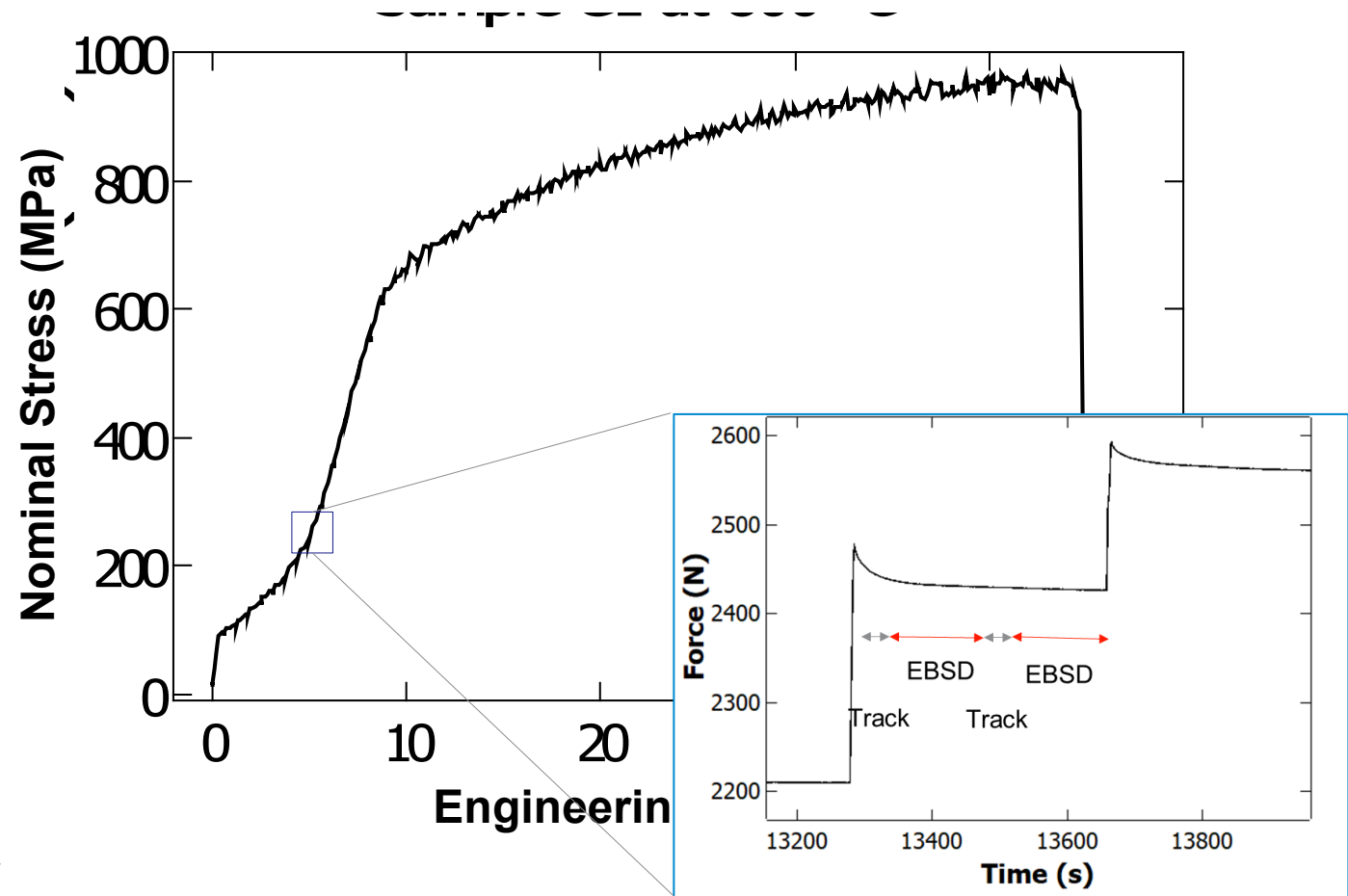
Tensile studies at elevated temperature



Two initial studies have been performed

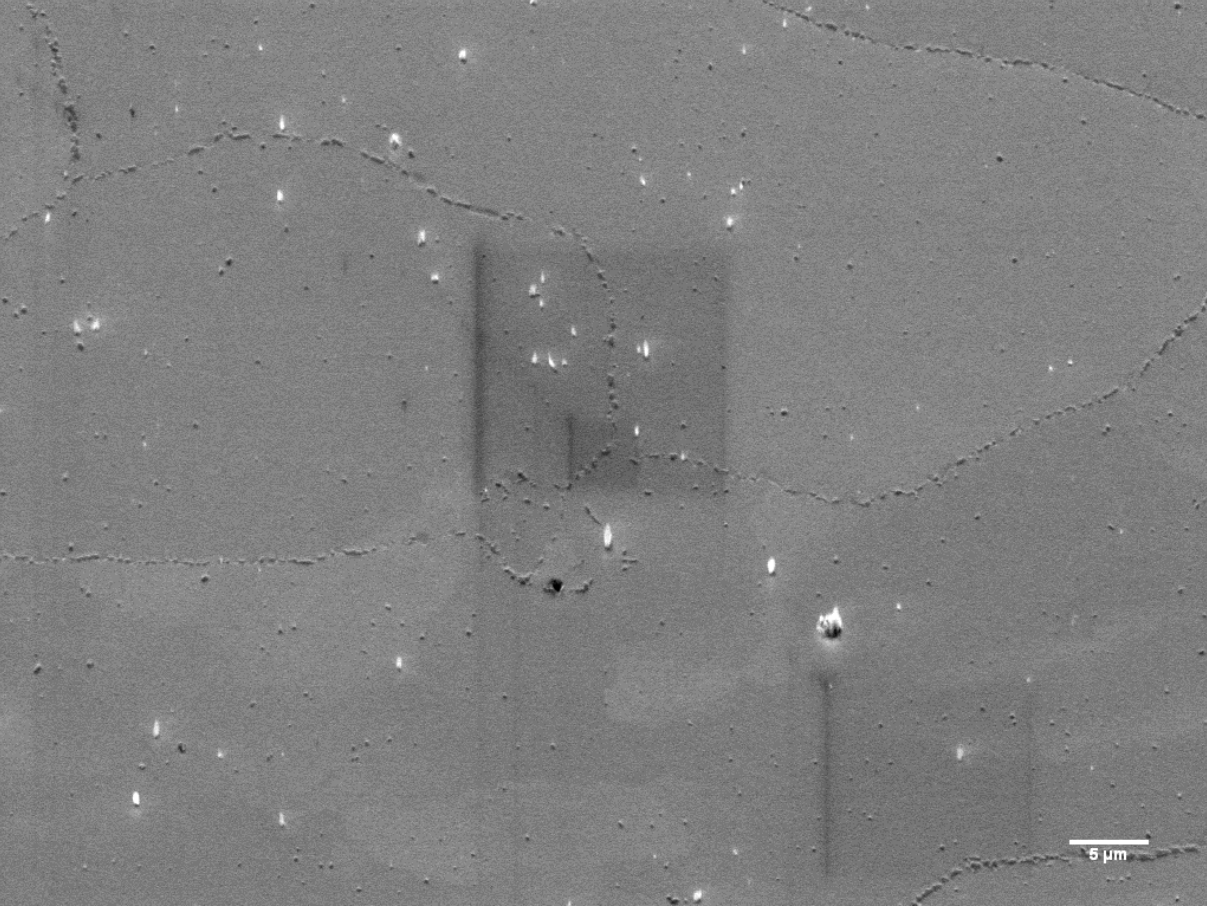
1. Tensile loading at elevated temperature to failure
2. Creep relaxation under elevated temperature at constant stress

Temperature held at 800C, but due to surface roughness of sample creating imperfect contact with heater, actual sample temperature likely somewhat lower

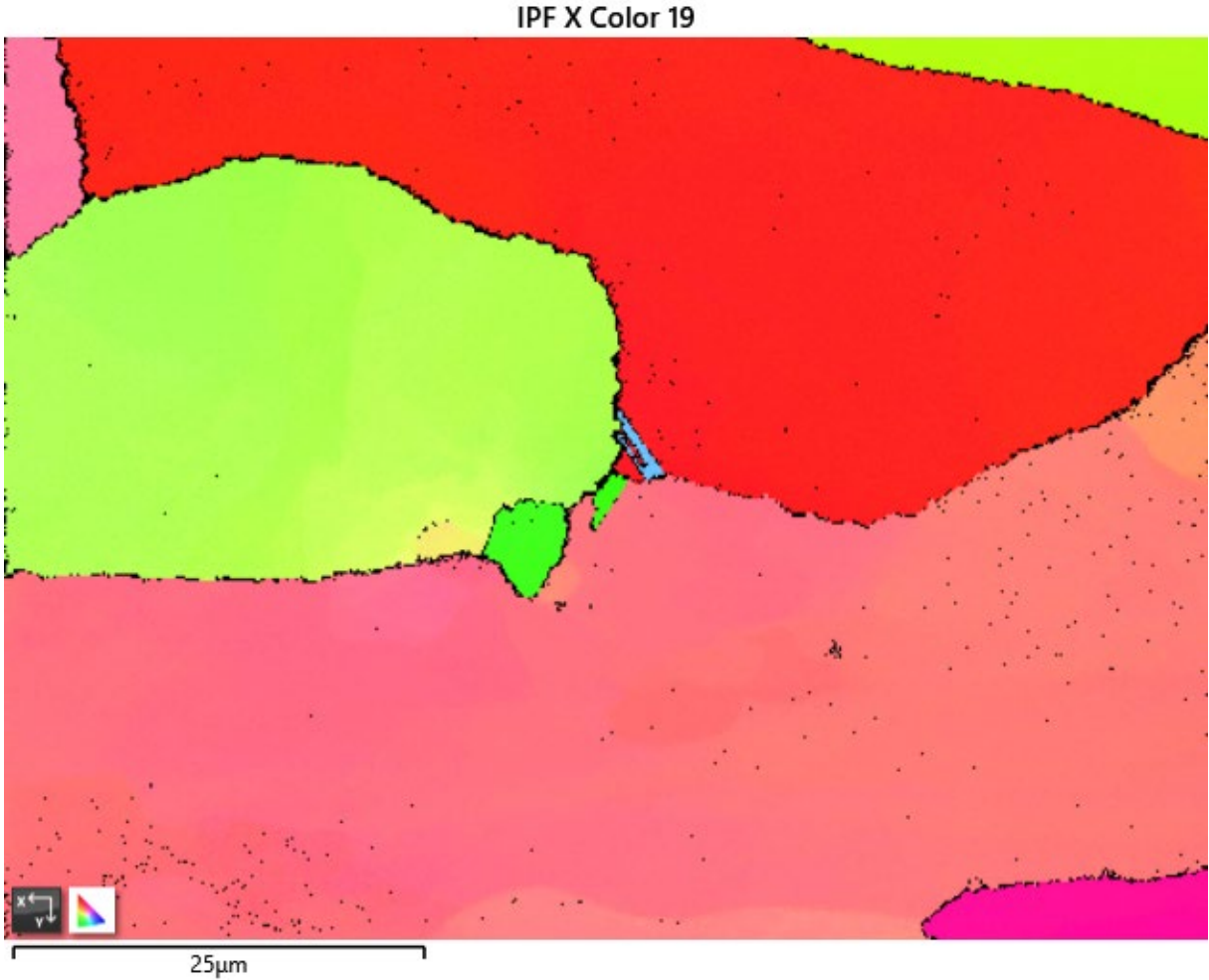


Part 1: Tensile Load Under Elevated Temp

Backscatter electron image

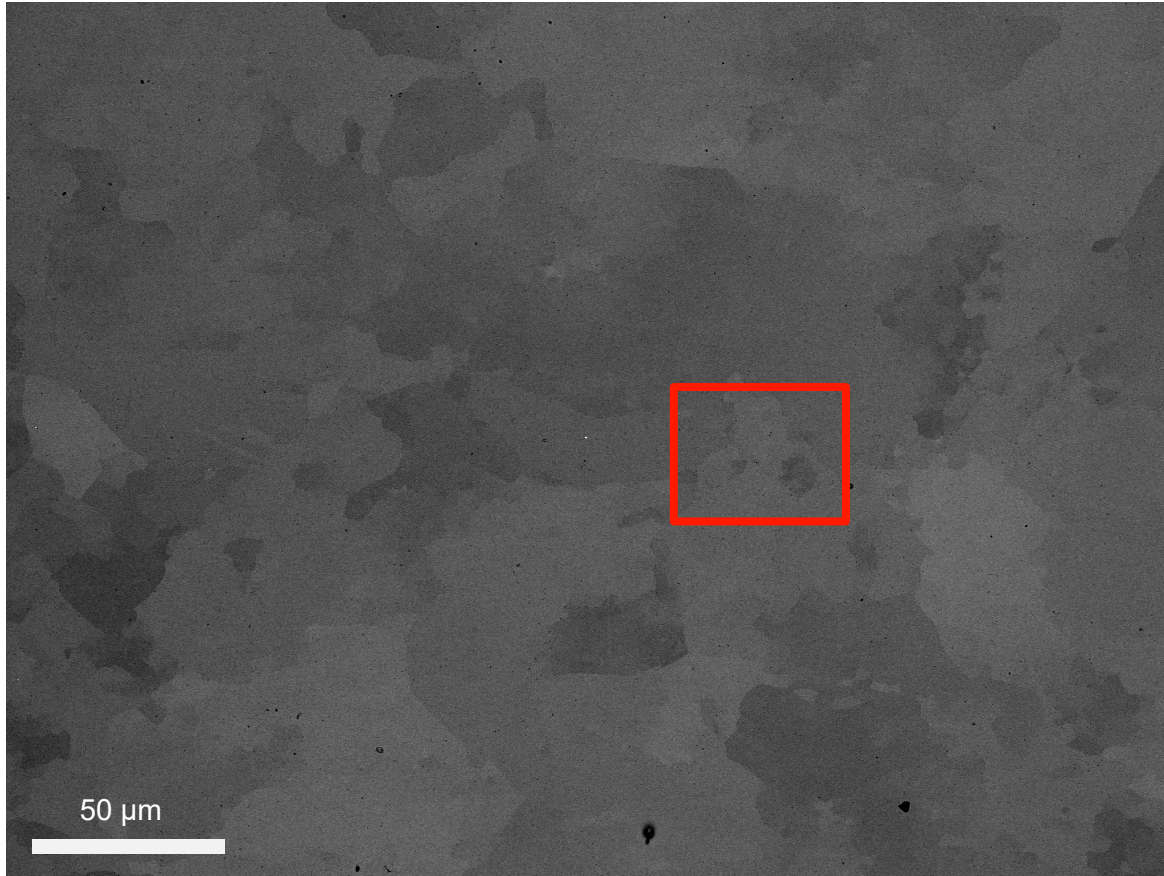


EBSD map

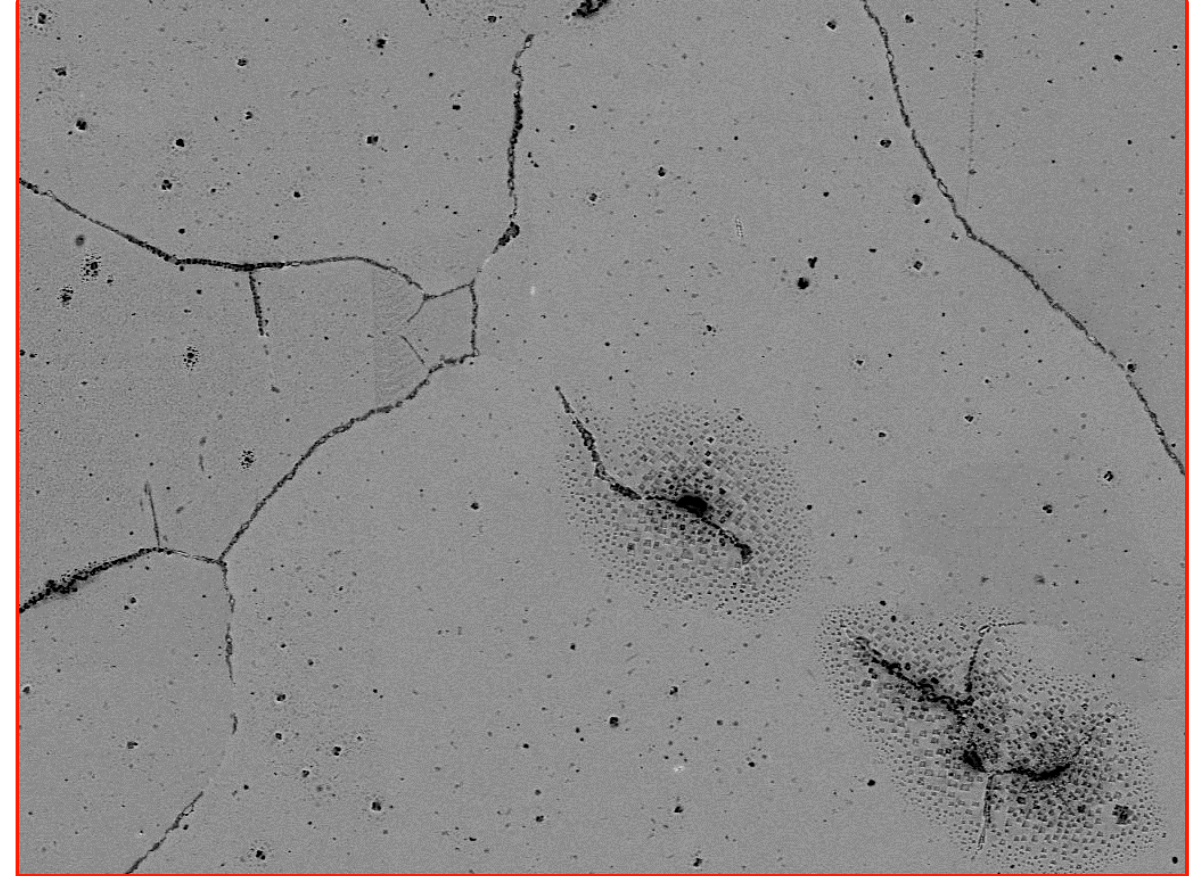


Part 2: Creep Relaxation Testing

Region of Interest 1

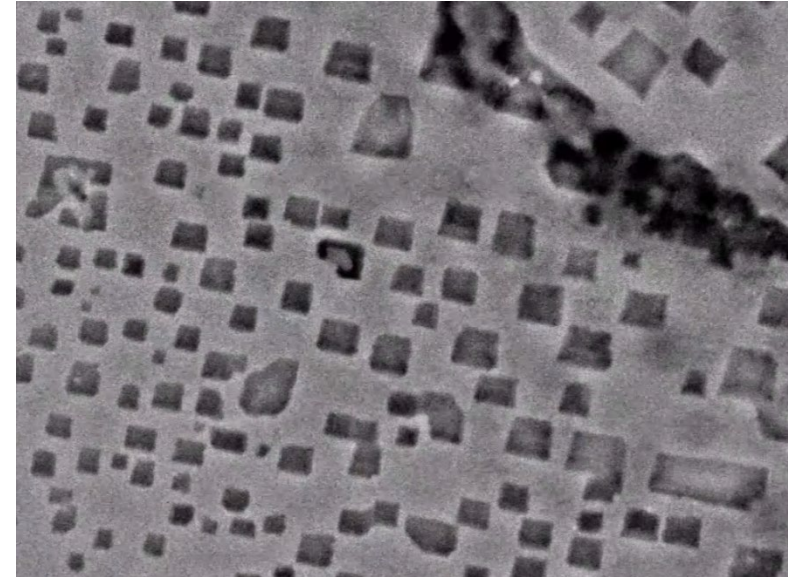
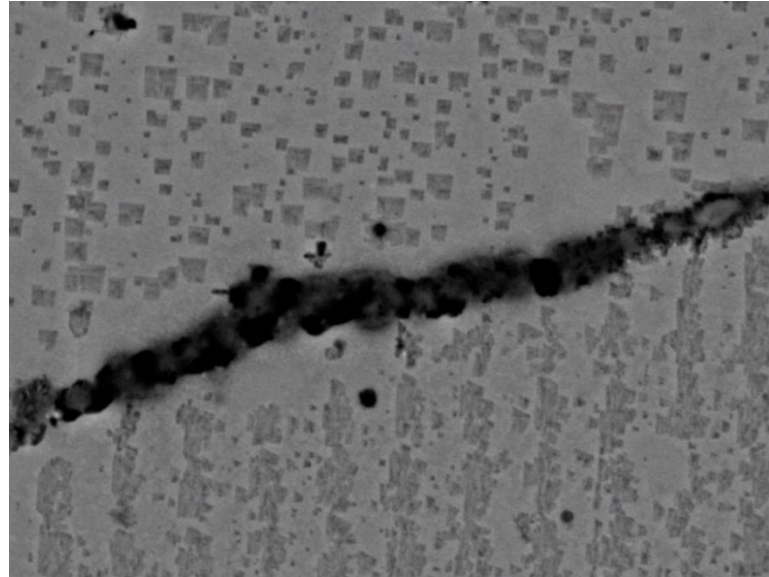
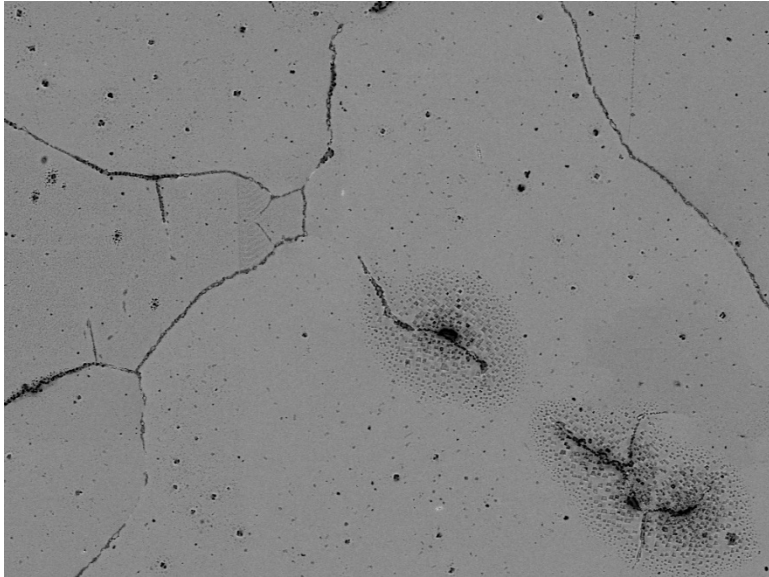


Region of Interest 2



Automated experiment time of 48 hours

Part 2: Creep Relaxation Testing

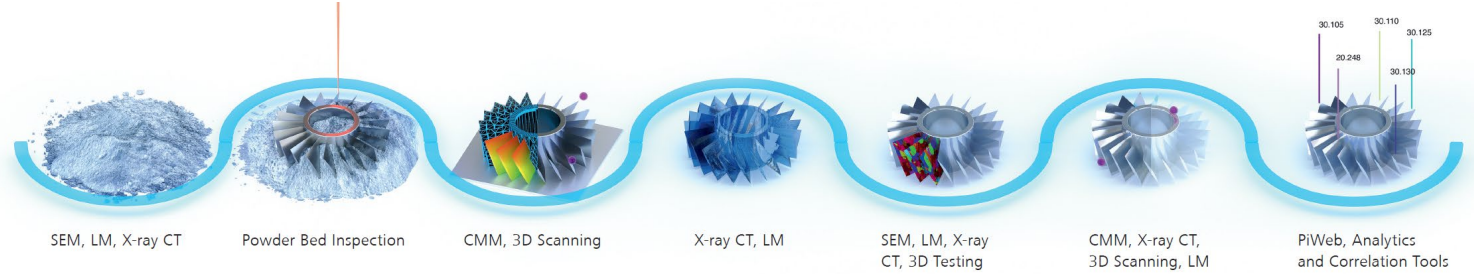


Visibility of gamma prime phase during creep relaxation. Note deformation dependency of precipitates based on local stress environment

Holistic Correlative Analysis



ZEISS Additive Manufacturing Solutions



Scanning Electron Microscope (SEM)



Light Microscope (LM)



In-Process Powder Bed Inspection



X-ray Computed Tomography (X-ray CT)



Coordinate Measuring Machine (CMM)



3D Testing



3D Scanning



ZEISS Crossbeam
Research-grade FIB-SEM enabling nanoscale material removal and 3D tomography for EDS and EBSD investigations.



ZEISS GeminiSEM
High-performance FE-SEM with EBSD and EDS, enabling microstructural crystallographic characterization and powder analysis.



ZEISS Smartproof 5
High-resolution and high-speed optical profilometer for detailed surface analysis.



ZEISS Smartzoom
With the digital microscope it is possible to view the sample from multiple directions while maintaining focus for speed and simplicity of use.

ZEISS AM in-process
In-process monitoring for automatic analysis of powder bed defects and classification for quality assurance.



ZEISS Xradia Versa
High-resolution X-ray CT to support detail analysis of powders, surfaces, and structures with voxel size down to 500 nm (160 kV).



ZEISS METROTOM
High-accuracy X-ray CT to support dimensional verification and defect analysis of parts with complex internal and external structures (225 kV).



ZEISS VoluMax
High-speed X-ray CT to support automated dimensional verification and defect detection of mass production quantities (225 kV).



ZEISS DuraMax HTG
The compact shop floor CMM allows investigation of post-build processes, showing any influences on dimensional accuracy of finished parts.



GOM ARAMIS
High-resolution 3D camera system for dynamic acquisition of 3D coordinates, 3D displacements and 3D surface strains.



GOM ATOS Q
Full-surface measurements for precise and detailed 3D meshes for 3D printing, reverse engineering or component inspection.



ZEISS EVO
Professional-grade SEM with EBSD and EDS, enabling efficient characterization of microstructures and elemental composition.



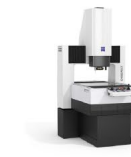
ZEISS Axio Imager
Microscope System for Automated Material Analysis – Introduce ease of operation into your microscopy workflow.



BOSELLO SRE MAX
High-power 2D X-ray inspection system able to penetrate large parts made from dense materials (450 kV).



ZEISS Xradia CrystalCT
Ground-breaking microCT for unlocking the crystallographic and microstructural secrets of your samples.



ZEISS O-INSPECT
Multisensor measuring machine enables to optimally measure each characteristic in compliance with ISO-10360 – optically or by contact.



ZEISS T-SCAN hawk
Portable, hand-held 3D laser scanner for confined spaces and hard-to-reach areas.

175
years



Challenge the limits of imagination